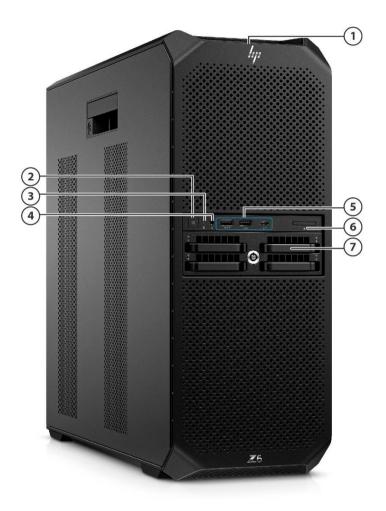
Overview

HP Z6 G5 A Workstation



- 1. Integrated Front Handle
- 2. Power Button
- 3. HDD Activity Light
- 4. CTIA Headset Jack

¹Premium Front IO is shown on photography

Front View

Front I/O Premium:
 1 USB 3.2 Gen2x2 Type-C[®], 2 USB 3.1 Gen1 Type-A (left-most Type-A port has Charging Capability)¹

Front I/O Entry: 4 USB 3.1 Gen1 Type-A (left-most Type-A port has Charging Capability)

- 6. SD Card Reader
- 7. 1 External 5.25" bay

Overview

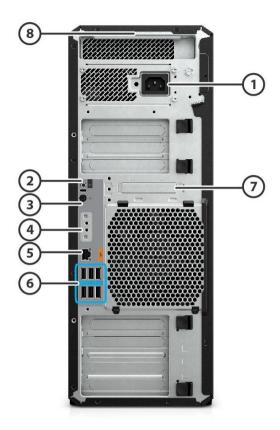


Internal View

- 1. 1 AMD Ryzen™ Threadripper™ PRO 7000WX Series Processor
- 2. 8 DIMM slots for DDR5 ECC Memory
- 3. Slot 1: PCIe Gen5 x16
 - Slot 2: PCIe Gen5 x16
 - Slot 3: Mechanical
 - Slot 4: PCIe Gen5 x16
 - Slot 5: PCIe Gen5 x16
 - Slot 6: PCIe Gen4 x16
 - Slot 7: PCIe Gen4 x4
- **NOTE:** Not shown in photography:
- 2x internal NVMe connectors to front removable M.2 carrier
- 2x internal USB Ports (1x single USB2.0 port, 1x USB3.0 port for SD card reader)
- 2x SATA ports

- 4. 4 internal onboard M.2 SSDs (2 PCIe x4 Gen5 and 2 PCIe x4 Gen4 system board connections)
- 5. 1 Internal 5.25" bay
- 6. 1 External 5.25" bay

Overview



. Choice of 775W, 1125W/1275W or 1450W, 90% Efficient Power Supplies

- 2. Rear Power Button
- 3. Universal Audio Jack
- 4. Flex I/O Module (optional)

Rear View

- 5. 1xRJ-45 integrated LAN port (1 GbE DASH)
- 6. 6 SuperSpeed USB3.2 Gen1 Type-A 5 Gbps signaling rate
- 7. 2x10GbE LAN ports (optional)
- 8. Integrated Rear Handle

Overview

Form Factor

Tower

Operating Systems

Preinstalled:

- Windows 11 Pro High End²
- Ubuntu 22.04 LTS⁴
- HP Linux®-ready (minimal OS ready for customer OS installation)⁵

License Only:

 Red Hat® Enterprise Linux® Desktop Workstation (includes paper license with 1 year support; no preinstalled OS)⁶

Supported:

- Windows 10 Pro for Workstations²
- Red Hat® Enterprise Linux® Workstation 8 & 9 6
- Ubuntu 22.04 LTS⁵

² Not all features are available in all editions or versions of Windows. Systems may require upgraded and/or separately purchased hardware, drivers, software or BIOS update to take full advantage of Windows functionality. Windows is automatically updated and enabled. High speed internet and Microsoft account required. ISP fees may apply and additional requirements may apply over time for updates. See http://www.windows.com.

⁴ Not all features are available in all editions or versions of Ubuntu. Systems may require upgraded and/or separately purchased hardware, drivers, software or BIOS to take full advantage of Ubuntu functionality. Ubuntu may be automatically updated. ISP fees may apply and additional requirements may apply over time for updates.

⁵A certified preloaded version of Ubuntu® 20.04 LTS is available from HP for this platform. Not all features are available in all editions or versions of Ubuntu. Systems may require upgraded and/or separately purchased hardware, drivers, software or BIOS to take full advantage of Ubuntu functionality. Ubuntu may be automatically updated. ISP fees may apply, and additional requirements may apply over time for upgrades.

⁶For detailed Linux[®] OS/hardware support information, see: http://www.hp.com/support/linux hardware matrix

NOTE: Your product does not support Windows 8 or Windows 7. In accordance with Microsoft's support policy, HP does not support the Windows® 8 or Windows 7 operating system on products configured with Intel® and AMD® 7th generation and forward processors or provide any Windows® 8 or Windows 7 drivers on http://www.support.hp.com. A full list of HP products and the Windows 10 versions tested is available on the HP support website. https://support.hp.com/us-en/document/c05195282

Overview

Processors

		Frequ (GH		L3 Cache	Memory Speed	TDP
Name ¹	Cores	Base Clock Speed	Boost Technology	(MB)	(MT/s)	(W)
AMD Ryzen™ Threadripper™ PRO 7995WX	96	2.5	5.1	384	5200	350
AMD Ryzen™ Threadripper™ PRO 7985WX	64	3.2	5.1	256	5200	350
AMD Ryzen™ Threadripper™ PRO 7975WX	32	4.0	5.3	128	5200	350
AMD Ryzen™ Threadripper™ PRO 7965WX	24	4.2	5.3	128	5200	350
AMD Ryzen™ Threadripper™ PRO 7955WX	16	4.5	5.3	64	5200	350
AMD Ryzen™ Threadripper™ PRO 7945WX	12	4.7	5.3	64	5200	350

NOTE:

- AMD Ryzen™ Threadripper™ PRO 7000WX Series processors do not offer integrated graphics
- AMD Ryzen™ Threadripper™ PRO 7000WX Series processors support ECC memory



¹ Multicore is designed to improve performance of certain software products. Not all customers or software applications will necessarily benefit from use of this technology. Performance and clock frequency will vary depending on application workload and your hardware and software configurations. AMD's numbering is not a measurement of clock speed.

Overview

Black Color **Convertibility** Nο

Expansion Slots (see system board section for more details) • Slot 3: Mechanical

 Slot 1: PCIe Gen5 x16 Slot 2: PCIe Gen5 x16 • Slot 4: PCIe Gen5 x16 • Slot 5: PCle Gen5 x16 • Slot 6: PCIe Gen4 x16

Slot 7: PCIe Gen4 x4

Expansion Bays

(see storage section for more details)

1x internal 3.5" bays (includes acoustic damping rail assembly)

1x external 5.25" bays (175mm depth limit)

Front I/O Front I/O Premium: 1x SuperSpeed USB Type-C[®] 20 Gbps signaling rate (USB Power Delivery 3.0), 2x

SuperSpeed USB Type-A 5 Gbps signaling rate, 1x headphone/microphone combo, SD card reader

(optional). [left-most Type-A ports supports BC1.2 (Battery Charging)]

Front I/O Entry: 4x SuperSpeed USB Type-A 5 Gbps signaling rate, 1x CTIA headset jack, SD card reader

(optional). [left-most Type-A ports supports BC1.2 (Battery Charging)]

Internal I/O [5] 2 USB ports and 2 SATA ports.

Rear I/O 1x Universal Audio Jack, 6x SuperSpeed USB Type-A 5 Gbps signaling rate, 1x RJ-45 integrated LAN port

(1 GbE, DASH), 2x10GbE Network Module (optional), Flex I/O (optional)

On-board RAID Support SATA RAID 0 Striped Array

SATA RAID 1 Mirrored Array SATA RAID 10 Striped/Mirrored SATA RAID 5 Parity Array

(See System Board section for more details on controller/Operating System dependencies and

configurability from factory)

Chassis Dimensions

(H x W x D)

Footprint:

H: 17.5" [444.5 mm] W: 6.65" [169 mm]

D: 18.3" [465 mm] (measured to the rear panel)

Maximum: H: 17.5" [444.5 mm] W: 6.65" [169 mm]

D: 18.51" [470.2 mm] (measured to the rear system fan)

Packaged Dimensions H: 24.0" [630mm]

W: 12.3" [313mm] D: 23.3" [593mm]

Palletization Profile 6 units x 3 layers = 18 units per pallet

1200x1000x1836mm (pallet included)

Rack Dimensions

Exact weights depend upon configuration (System weight only). Weight

> Minimum: 13.2.4kg (29.1lbs.) Typical: 14.8kg (32.6lbs.) Maximum: 23.1kg (50.9lbs.)

Power Supply Choice of 80 Plus Gold (90% efficiency at 50% load) Power Supplies:

- 1450W @230V (Delta Efficiency Report)
- 1125W/1275W @110V (Delta Efficiency Report)
 - 775W @230V (Delta Efficiency Report)
 - 775W @110V (Delta Efficiency Report)
 - 775W @230V (LiteOn Efficiency Report)



Overview

• 775W @110V (LiteOn Efficiency Report)

NOTE: not all configurations are supported on all power supplies. Configuration support depends on total system power budget and having sufficient number or type of PCIe supplemental power connectors. Confirm power supply and configuration support using configurator on hp.com.

- 1450W supports up to 900W of auxiliary graphics power (dependent on system configuration)
 - 1125W/1275W supports up to 600W of auxiliary graphics power (dependent on system configuration)
- 775W supports up to 230W of auxiliary graphics power (dependent on system configuration)

NOTE: updating graphics after purchase may require additional power distribution cables and/or auxiliary graphics adapters to support the new graphics configuration.

Workstation ISV Certifications Chipset See the latest list of certifications at

http://www.hp.com/united-states/campaigns/workstations/partnerships.html

AMD PRO 695 Chipset

Memory 8 DIMM slots, supporting up to 1TB, DDR5 5200 MT/s speed depending on the system configuration



Supported Components

Processors		Factory Configured	Option Kit	Option Kit Part Number	Support Notes
	AMD Ryzen™ Threadripper™ PRO 7995WX	Υ	N		
	AMD Ryzen™ Threadripper™ PRO 7985WX	Υ	N		
	AMD Ryzen™ Threadripper™ PRO 7975WX	Υ	N		
	AMD Ryzen™ Threadripper™ PRO 7965WX	Υ	N		
	AMD Ryzen™ Threadripper™ PRO 7955WX	Υ	N		
	AMD Ryzen™ Threadripper™ PRO 7945WX	Υ	N		

SATA Hard Drives		Factory Configured	Option Kit	Option Kit Part Number
	1TB 7200 SATA 3.5" HDD	Υ	Υ	
	1TB 7200 SATA 3.5" Enterprise HDD	Υ	Υ	WOR10AA
	2TB 7200RPM SATA 3.5in Enterprise HDD	Υ	Υ	2Z274AA
	4TB 7200 RPM SATA 3.5in Enterprise HDD	Υ	Υ	K4T76AA/AT
	8TB 7200RPM SATA 3.5in Enterprise HDD	Υ	Υ	2Z273AA
	12TB 7200 RPM SATA-6G 3.5in Enterprise HDD	Υ	Υ	5S461AA
	HP 2.5in to 3.5in HDD Adapter Kit	N	Υ	J5T63AA
	HP 2.5in to 3.5in HDD Adapter Kit	N	Y	IST63AA

NOTE: Starting November 1, 2023, HP PCs with Windows require Windows to be installed on SSD. HDD can only be configured as additional data drives and not as the boot drive.

NOTE: For internal bay install, HDD option kits require separate purchase of 74Y88AA HP Z6 A HDD Cable Kit.

NOTE: For storage drives, GB = 1 billion bytes. TB = 1 trillion bytes. Actual formatted capacity is less. Up to 35GB of system disk (for Windows) is reserved for system recovery software.

PCIe Solid State Drives		Factory Configured	Option Kit	Option Kit Part Number
	Z Turbo 512GB PCIe-4x4 2280 TLC M.2 SSD Module ⁴	Υ	Υ	38T80AA
	Z Turbo 512GB PCIe-4x4 2280 SED OPAL2 TLC M.2 SSD Module ⁴	Υ	Υ	38T81AA
	Z Turbo 512GB PCIe-4x4 2280 TLC Z4/Z6 Kit SSD ³	N	Υ	56Q73AA
	Z Turbo 512GB PCIe-4x4 2280 SED OPAL2 TLC M.2 Z4/Z6 Kit SSD ³	N	Υ	56Q74AA
	Z Turbo 1TB PCIe-4x4 2280 TLC SSD Module ⁴	Υ	Υ	38T77AA
	Z Turbo 1TB PCIe-4x4 2280 SED OPAL2 TLC M.2 SSD Module ⁴	Υ	Υ	38T76AA
	Z Turbo 1TB PCIe-4x4 2280 TLC Z4/Z6 Kit SSD ³	N	Υ	56Q75AA
	Z Turbo 1TB PCIe-4x4 2280 SED OPAL2 TLC M.2 Z4/Z6 Kit SSD ³	N	Υ	5Z7E7AA
	Z Turbo 2TB PCIe-4x4 2280 TLC SSD Module ⁴	Υ	Υ	38T75AA
	Z Turbo 2TB PCIe-4x4 2280 SED OPAL2 TLC M.2 SSD Module ⁴	Υ	Υ	38T79AA
	Z Turbo 2TB PCIe-4x4 2280 SED OPAL2 TLC M.2 Z4/Z6 Kit SSD ³	N	Υ	56Q77AA
	Z Turbo 4TB PCIe-4x4 2280 TLC M.2 SSD Module ⁴	Υ	Υ	5S496AA/AT

Supported Components

Υ	Υ	5S497AA/AT
N	Υ	5S4A1AA
Υ	Υ	7H9Z3AA
Υ	N	
Υ	N	
Υ	N	
Υ	N	
Υ	Υ	56Q86AA
Υ	N	
Υ	N	
Υ	N	
Υ	N	
	Y Y Y Y Y Y Y Y	Y Y Y Y Y N Y N Y N Y N Y N Y N Y N Y N

Note 1: Kit includes dual pro carrier and heatsink. Requires separate purchase of Z Turbo PCIe 4x4 M.2 SSD modules.

Note 2: Kit includes quad pro carrier and heatsink. Requires separate purchase of Z Turbo PCIe 4x4 M.2 SSD modules.

Note 3: Includes a heatsink.

Note 4: Does not include a heatsink.

NOTE: For storage drives, GB = 1 billion bytes. TB = 1 trillion bytes. Actual formatted capacity is less. Up to 35GB of system disk (for Windows) is reserved for system recovery software.

Graphics		Factory Configured	Option Kit	Option Kit Part Number	Supported # of cards
Graphics Cable	HP DisplayPort to HDMI Adapter	Υ	Υ	2JA63AA	
Adapters	HP DisplayPort to DVI Adapter (Bulk 90)	N	Υ	FH973A6	
	HP DisplayPort to VGA Adapter	N	Υ	AS615AA/AT	
	HP DisplayPort to VGA Adapter	N	Υ	F7W97AA	
	HP miniDP-to-DP Adapter Cable (single)	Υ	Υ	2MY05AA	
	HP miniDP-to-DP Adapter Cable (2-pack)	Υ	N		
	HP miniDP-to-DP Adapter Cable (4-pack)	Υ	N		
	HP miniDP-to-DP Adapter Cable (8-pack)	Υ	N		
	HP miniDP-to-DP Adapter Cable (Bulk 12)	N	Υ	2KW87A6	
	HP Graphics Power Cable CPU-8p to CPU-8p 4	N	Υ	6J6H7AA	
	HP Graphics Power Cable CPU-8p to x2 PCIe 8p(6+2) ⁴	N	Υ	6J6H8AA	
	NVIDIA 3D Stereo Bracket	N	Υ	KOA25AA	
	NVIDIA Quadro Sync II	N	Υ	1WT20AA	
Ultra High-End	NVIDIA® A800 40 GB Graphics ⁷	Υ	Υ	8D6C0AA	2
Graphics	NVIDIA® RTX A6000 48 GB 4DP Graphics	N	Υ	2S6U3AA	
	NVIDIA® RTX 6000 Ada 48GB 1,3	Υ	Υ	79C23AA	3
	NVIDIA® RTX 6000 Ada 48 GB 4DP w/NVIDIA	N	Υ	9X3E1AA	3

Supported Components

	Omniverse Enterprise Graphics ^{1,3}				
	AMD® Radeon™ Pro W7900 48GB ^{1,8}	Υ	Υ	8F699AA	1
	NVIDIA® RTX 5000 Ada 24GB ¹	Υ	Υ	8D6B6AA	3
	NVIDIA Quadro Sync II	N	Υ	1WT20AA	
High-End Graphic	s NVIDIA® RTX 4500 Ada 24 GB	Υ	Υ	8D6C1AA	3
	NVIDIA® RTX A4500 20GB 1	Υ	Υ	5S458AA/AT	3
	NVIDIA® RTX 4000 Ada 16GB 1,5	Υ	Υ	8D6B7AA	3
	NVIDIA® RTX A4000 16GB 1,5	Υ	Υ	20X24AA/AT	3
	NVIDIA® RTX 2000 Ada 16 GB	Υ	Υ	8D6B8AA	3
	NVIDIA® RTX A2000 12GB ¹	Υ	Υ	5Z7D9AA/AT	3
Mid-range	NVIDIA® RTX A1000 8 GB 4mDP Graphics	Υ	Υ	9U276AA	3
Graphics	NVIDIA® T1000 8GB ²	Υ	Υ	5Z7D8AA/AT	3
	AMD® Radeon™ Pro W7600 8GB ¹	Υ	Υ	8D6B9AA	3
	AMD® Radeon™ Pro W7500 8GB ¹	Υ	Υ	8D6C2AA	3
Entry Graphics	NVIDIA® RTX A400 4 GB 4mDP Graphics ²	Υ	Υ	9U277AA	2
	NVIDIA® T400 4GB ²	Υ	Υ	5Z7EOAA/AT	3
	AMD® Radeon™ RX 6400 4GB	Υ	Υ	6Q3U4A	1

Note 1: Single, dual, or triple graphics configurations require the HP Z6 Fan and Front Card Guide. If configured as an after-market option, a separate purchase of the HP Z6 Fan and Front Card Guide 56Q80AA is required. If factory configured, the fan and front card guide is included.

Note 2: Dual or triple graphics configurations require the HP Z6 Fan and Front Card Guide. If configured as an after-market option, a separate purchase of the HP Z6 Fan and Front Card Guide 56Q80AA is required. If factory configured, the fan and front card guide is included.

Note 3: Triple graphics configuration requires the HP Z6 PCIe Retainer with Fans. If configured as an aftermarket option, a separate purchase of the HP Z6 PCIe Retainer with Fans 56Q85AA is required. If factory configured, the PCIe retainer with fans is included.

Note 4: Required for select graphics configurations.

Note 5: Only supported with 1125W/1275W and 1450W PSUs

Note 6: Not available at launch; available early 2024

Note 7: The NVIDIA® A800 is meant for GPU compute and does not have video outputs. A graphics card must be configured in addition with the A800.

Note 8: AMO kit support expected June 2024.

Memory		Factory Configured	Option Kit	Option Kit Part Number	Support Notes
	32GB (2x16GB) DDR5 5600 DIMM ECC REG Memory	Υ	N		
	64GB (4x16GB) DDR5 5600 DIMM ECC REG Memory	Υ	N		
	64GB (2x32GB) DDR5 5600 DIMM ECC REG Memory ²	Υ	N		
	128GB (8x16GB) DDR5 5600 DIMM ECC REG Memory ²	Υ	N		
	128GB (4x32GB) DDR5 5600 DIMM ECC REG Memory ²	Υ	N		
	256GB (8x32GB) DDR5 5600 DIMM ECC REG Memory ²	Υ	N		
	256GB (4x64GB) DDR5 5600 DIMM ECC REG Memory ²	Υ	N		
	256GB (2x128GB) DDR5 5600 DIMM ECC REG Memory ^{1,2}	Υ	N		
	512GB (8x64GB) DDR5 5600 DIMM ECC REG Memory ²	Υ	N		
	512GB (4x128GB) DDR5 5600 DIMM ECC REG Memory ^{1,2}	Y	N		



Supported Components

1TB (8x128GB) DDR5 5600 DIMM ECC REG Memory ^{1,2}	Υ	N	
After Market Options			
16GB (1x16GB) DDR5 5600 DIMM ECC REG Memory	Υ	Υ	760N2AA
32GB DDR5 (1x32GB) 5600 DIMM ECC REG Memory ²	N	Υ	760R7AA
64GB DDR5 (1x64GB) 5600 DIMM ECC REG Memory ²	N	Υ	760R8AA
128GB (1x128GB) DDR5 5600 DIMM ECC REG Memory ^{1,2}	N	Υ	760R9AA

Note 1: This memory configuration requires the 1125W/1275W/1450W PSU

Note 2: Configurations with 32GB DIMMs or greater come with memory fan installed

NOTE: The CPUs determine the speed at which the memory is clocked. For example, if a 4800MHz capable CPU is used in the system, the maximum speed the memory will run at is 4800MHz regardless of the specified speed of the memory.

Multimedia and Audio Devices		Factory Configured	Option Kit	Option Kit Part Number
	Poly Savi 8210/8220 Universal Power Supply - 9V 500mA	N	Υ	783M9AA
	Poly Savi 7310 Headset	N	Υ	783N0AA
	Poly Savi 7320 Headset	N	Υ	783N1AA
	Poly Savi 7310 Headset (Teams)	N	Υ	783N2AA
	Poly Savi 7320 Headset (Teams)	N	Υ	783N3AA
	Poly Savi 7210 Headset	N	Υ	783Q5AA
	Poly Savi 7220 Headset	N	Υ	783Q6AA
	Poly BT700 USB-A Bluetooth Adapter	N	Υ	786C4AA
	Poly BT700 USB-C Bluetooth Adapter	N	Υ	786C5AA
	Poly DA75 USB to QD Adapter	N	Υ	786C6AA
	Poly DA85 USB to QD Adapter	N	Υ	786C7AA
	Poly DA85-M USB to QD Adapter	N	Υ	786C8AA
	Poly Voyager Office Base	N	Υ	786C9AA
	Poly Voyager Office Base Teams	N	Υ	786D0AA
	HyperX Cloud MIX Wireless GAM HEADSET	N	Υ	4P5K9AA
	HyperX Cloud Core Black Gaming Headset	N	Υ	4P4F2AA
	HyperX Cloud Flight - Wireless Gaming Headset (Black-Red) (HX-HSCF-BK/AM)	N	Υ	4P5L4AA
	HyperX Cloud Stinger Core GAM HEADSET PC	N	Υ	4P4F4AA
	HyperX Cloud II Core Wireless GAM HEADSET	N	Υ	6Y2G8AA
	HyperX SoloCast - USB Microphone (Black) (HMIS1X-XX-BK/G)	N	Υ	4P5P8AA

Optical and Removable Storage		Factory Configured	Option Kit	Option Kit Part Number
	HP CRU QX448 Removable with 200mm Cable (Qty.2) Frame/Carrier ^{1,2}	Y Y	N	-
	HP CRU Secure High Performance Storage Module with 2TB M.2 SSD ³	Υ	Υ	56Q87AA
	HP CRU Secure High Performance Storage Module with 1TB M.2 SSD ³	Υ	Υ	56Q88AA
	HP CRU Secure High Performance Storage Module with 512GB M.2 SSI)3 Y	Υ	56Q89AA
	HP 9.5mm Slim DVD-ROM Drive	Υ	Υ	K3R63AA
	HP 9.5mm Slim Blu-Ray BDXL Writer Drive	Υ	Υ	K3R65AA



Supported Components

HP 9.5mm Slim DVD Writer

Υ

Υ

K3R64AA

NOTE: Duplication of copyrighted material is strictly prohibited. Actual speeds may vary. Double Layer media compatibility will widely vary with some home DVD players and DVD-ROM drives. No support for DVD RAM.

NOTE: With Blu-Ray, certain disc, digital connection, compatibility and/or performance issues may arise, and do not constitute defects in the product. Flawless playback on all systems is not guaranteed. In order for some Blu-ray titles to play, they may require a DVI or HDMI digital connection and your display may require HDCP support. HD-DVD movies cannot be played on this Desktop PC.

Note 1: Optional separate purchase of HP CRU Secure High Performance Storage (SHIPS) Module(s).

Note 2: Front QX448 carrier supports hot-swap capability with front removable drives

Note 3: HP CRU SHIPS Module Kit contains select M.2 SSD for install into a factory configured front removeable storage carrier (HP CRU QX448 Frame/Carrier).

Networking and Communications		Factory Configured	Option Kit	Option Kit Part Number
	NVIDIA Mellanox ConnectX-6 DX Dual Port 10/25GbE SFP28 NIC	Υ	Υ	436M8AA
	HP 10GbE SFP+ SR/SW LC Fiber Optic Transceiver	Υ	Υ	860T8AA
	HP 25GbE SFP28 LC Fiber Optic Transceiver	Υ	Υ	860T9AA
	HP Dual Port 10GbE NIC G2 ¹	Υ	Υ	360K6AA
	Intel® X550 Dual Port 10GbE NIC	Υ	Υ	1QL46AA
	Allied Telesis AT-2911T/2-901 Dual Port 1GbE NIC	Υ	Υ	6E3Y9A
	AT-2914SX/LC-901 Single Port 1GbE NIC	Υ	Υ	1C7Q2AA
	Intel® I350-T4 4-Port 1GbE NIC	N	Υ	W8X25AA
	HP Flex 10GbE Single Port	Υ	Υ	56Q71AA
	HP Flex 2.5GbE LAN Single Port	Υ	Υ	169KOAA/AT
	Intel® I226-T1 Single Port 2.5GbE PCIe NIC	Υ	Υ	9P1U8AA
	HP Flex 1GbE Fiber Single Port LC	Υ	Υ	20J15AA
	HP Flex 1GbE Single Port NIC	Υ	N	
	HP Flex MediaTek RZ616 Wi-Fi 6 +Bluetooth® 5.3 WLAN wireless card with Internal Antenna	Y	N	
	Intel® AX210 Wi-Fi 6E non-vPro + Bluetooth® 5.2 wireless card with External Antenna WLAN	Υ	Υ	340L7AA

Note1: installation of component does not require PCIe slot

HP Remote System Controller		Factory Configured	Option Kit	Option Kit Part Number
	HP Remote System Controller	Υ	Υ	7K6D7AA
	HP Remote System Controller Main Board Adapter	Υ	Υ	7K6D8AA
	HP Integrated Remote System Controller	Υ	Υ	7K6D9AA
	HP Remote System Controller for Universal KVM	N	Υ	7K7N2AA

NOTE:

HP Remote System Controller is an IT Manager targeted manageability feature.

HP Remote access software is an End User centric and available as a separate AMO accessory.



Supported Components

Racking and Physical Security		Factory Configured	Option Kit	Option Kit Part Number
	Z2 Mini/Z2 Tower/Z4/Z6 Depth Adjustable Fixed Rail Rack Kit	N	Υ	2A8Y5AA
	HP Keyed Cable Lock	N	Υ	T1A62AA
	HP Master Keyed Cable Lock 10mm	N	Υ	T1A63AA
Input Devices		Factory Configured	Option Kit	Option Kit Part Number
	Mouse and Keyboard Combo			
	HP 655 Wireless Keyboard and Mouse Combo	N	Υ	4R009AA/ET/UT/A6
	HP Wired Desktop 320MK Mouse and Keyboard	N	Υ	9SR36AA/ET/UT
	Keyboard only			
	HP 320K Wired Keyboard	Υ	Υ	9SR37AA/ET/UT
	HP 125 Wired Keyboard	Υ	Υ	266C9AA/ET/UT
	HP 975 USB+BT Dual-Mode Wireless Keyboard	N	Υ	3Z726AA/UT
	HP 455 Programmable Wireless Keyboard	N	Υ	4R177AA/ET/UT/A6
	HP Business Slim Smartcard Keyboard	Υ	Υ	Z9H48AA/AT
	HyperX MKW100 Red Gaming Keyboard	N	Υ	4P5E1AA
	Mouse only			
	HP Wired 320M Mouse	Υ	Υ	9VA80AA/ET/UT
	HP Creator 935 Black Wireless Mouse	N	Υ	1DOK8AA/UT
	HP 128 LSR Wired Mouse	Υ	Υ	265D9AA/ET/UT
	HP 125 Wired Mouse	N	Υ	265A9AA/ET/UT
	HyperX Pulsefire Core Black USB Gaming Mouse	N	Υ	4P4F8AA
	HyperX Pulsefire Haste White Wireless Gaming Mouse 2	N	Υ	6N0A9AA
	HyperX Pulsefire Haste Black Wireless Gaming Mouse 2	N	Υ	6N0B0AA
	NOTE: Keyboard and Mouse are optional or add on features.			

Other Hardware		Factory Configured	Option Kit	Option Kit Part Number
	HP Flex USB-C 3.2 Gen2	Υ	Υ	141K6AA/AT
	HP Flex Dual USB-A 3.2 Gen1	Υ	Υ	141J8AA/AT
	HP Flex Serial Port v3	Υ	Υ	5B895AA
	HP Dual Thunderbolt4 PCIe x4 Low Profile Card	Υ	Υ	340L1AA
	HP Type-C SuperSpeed USB 20Gbps Front v3 Premium Module	Υ	Υ	8R3X3AA
	HP Internal Serial+PS/2 Port	Υ	Υ	56Q78AA
	HP USB 2.0 Type-A Port Adapter Kit ¹	N	Υ	79C24AA
	HP SD Card Reader Zx G4	Υ	Υ	2VK54AA
	HP Z6 G5 A Fan and Front Card Guide Kit ³	Υ	Υ	760N5AA
	HP Z6 G5 A Memory Cooling Solution ²	Υ	Υ	760N6AA
	HP Z6 G5 A PCIe Retainer with Fans ³	Υ		760N7AA



Supported Components

HP C13 1.83m Power Cord Kit (halogen-free)	Υ	N	
HP C13 1.83m Power Cord Kit	Υ	Υ	6Z1T9AA
HP C13-C14 2.0m Power Cord Kit	Υ	N	
C13-C14 2.0m 15A 100-127V Countries Straight Desktop Power Cord	Υ	N	8R881AA
C13-C14 2.0m 10A 200-240V Countries Straight Desktop Power Cord	Υ	N	8R882AA
HP Z4/Z6 A HDD Cable Kit	N	Υ	74Y88AA

Note 1: USB 2.0 Type-A Port Adapter Kit has a single USB 2.0 type A connector.

Note 2: HP Z6 G5 A Memory Cooling Solution 760N6AA is required as a separate purchase for after-market memory configurations using 32GB Registered DIMMs or greater. If configured from the factory, configurations using 32GB Registered DIMMs or greater will include a memory cooling solution.

Note 3: HP Z6 G5 A Fan and Front Card Guide Kit 760N5AA and HP Z6 G5 A PCIe Retainer with Fans 760N7AA are required for specific graphics configurations (see Graphics section).

Software		Factory Configured	Option Kit	Support Notes
	HP Performance Advisor	Υ	N	1
	HP PC Hardware Diagnostics UEFI	Υ	N	2
	HP PC Hardware Diagnostics Windows	Υ	N	
	HP Wolf Security	Υ	N	4
	HP Notifications	Υ	N	
	HP Desktop Support Utility	Υ	N	
	HP Documentation	Υ	N	
	myHP	Υ	N	
	Kingsoft WPS Office	Υ	N	5
	Z by HP Data Science Stack Manager	Υ	N	3,6
	WSL2/Ubuntu Data Science Stack	Υ	N	3
	HP Image Assistant	N	N	
	HP Support Assistant	N	N	
	Wolf Pro Security			7

Note 1: Also available as a free download from http://www.hp.com/qo/performanceadvisor

Note 2: Windows OS only

Note 3: Only available with NVIDIA graphics

Note 4: HP Wolf Security for Business requires Windows 10 or 11 Pro higher, includes various HP security features and is available on HP Pro, Elite, RPOS and Workstation products. See product details for included security features.

Note 5: Not available in China

Note 6: Z by HP Data Science Stack Manager requires Windows 10 version 21H2 (Build 19044) and higher or 64-bit Ubuntu 20.04 and is available on select Z workstations.

Note 7: HP Wolf Pro Security Edition is available preloaded on select SKUs, and, depending on the HP product purchased, includes a license with a term length communicated to you at purchase and in your order confirmation email. The HP Wolf Pro Security Edition software is licensed under the license terms of the HP Wolf Security Software - End-User license Agreement (EULA) that can be found at: https://support.hp.com/us-en/document/ish_3875769-3873014-16 as that EULA is modified by the following: 7. Term. Unless otherwise terminated earlier pursuant to the terms contained in this EULA, the license for the HP Wolf Pro Security Edition is effective upon 4 months after the date the HP Product was



Supported Components

shipped by HP and will continue for the term communicated to you at purchase and in your order confirmation email ("Initial Term"). At the end of the Initial Term you may either (a) purchase a renewal license for the HP Wolf Pro Security Edition from HP.com, HP Sales or an HP Channel Partner, or (b) continue using the standard versions of HP Sure Click and HP Sure Sense at no additional cost with no future software updates or HP Support. Notwithstanding the foregoing, the license shall expire no later than one year after the fixed term of the subject license ends.



Supported Components

Operating Systems Windows 11 Pro High End²

Windows 10 Pro for Worskations^{2,5}

Ubuntu 22.04 LTS4

HP Linux®-ready

Red Hat® Enterprise Linux® (RHEL) Workstation - paper

² Not all features are available in all editions or versions of Windows. Systems may require upgraded and/or separately purchased hardware, drivers, software or BIOS update to take full advantage of Windows functionality. Windows is automatically updated and enabled. High speed internet and Microsoft account required. ISP fees may apply and additional requirements may apply over time for updates. See http://www.windows.com.

³This system is preinstalled with Windows 10 Pro software and also comes with a license for Windows 11 Pro software and provision for recovery software. You may only use one version of the Windows software at a time. Switching between versions will require you to uninstall one version and install the other version. You must back up all data (files, photos, etc.) before uninstalling and installing operating systems to avoid loss of your data.

⁴ Not all features are available in all editions or versions of Ubuntu. Systems may require upgraded and/or separately purchased hardware, drivers, software or BIOS to take full advantage of Ubuntu functionality. Ubuntu may be automatically updated. ISP fees may apply and additional requirements may apply over time for updates.

⁵ Not available as factory image, support only.

NOTE: Your product does not support Windows 8 or Windows 7. In accordance with Microsoft's support policy, HP does not support the Windows® 8 or Windows 7 operating system on products configured with Intel® and AMD® 7th generation and forward processors or provide any Windows® 8 or Windows 7 drivers on http://www.support.hp.com. A full list of HP products and the Windows 10 versions tested is available on the HP support website. https://support.hp.com/us-en/document/c05195282



Supported Components

SOFTWARE COMPONENTS AND APPLICATIONS WITH WINDOWS

Software

HP Anyware

HP Performance Advisor¹

HP PC Hardware Diagnostics UEFI

HP PC Hardware Diagnostics Windows

HP Wolf Security²²

HP Notifications

HP Desktop Support Utility

HP Documentation

myHP

HP Privacy Settings

HP Easy Clean

Kingsoft WPS Office (China only)

WSL2/Ubuntu Data Science Stack

HP Image Assistant (Supported)

HP Support Assistant (Supported)

HP Services Scan²⁵

Security Management

HP Secure Erase¹⁶

HP Wolf Pro Security Edition (paid option)¹⁸

HP Wolf Security for Business²²

HP Sure Click⁵

HP Sure Sense⁶

HP Sure Run GenX⁹

HP Sure Recover GenX¹⁰

HP Sure Start GenX⁸

HP Tamper Lock¹²

HP Sure Admin¹¹

HP Client Security Manager GenX4

- ¹ HP Performance Advisor Software HP Performance Advisor is ready to help you get the most out of your HP Workstation from day one—and every day after. Learn more or download at: http://hp.com/PerformanceAdvisor
- ² HP Driver Packs not preinstalled, however available for download at http://www.hp.com/go/clientmanagement.
- ³ HP Manageability Integration Kit can be downloaded from https://ftp.ext.hp.com/pub/caps-softpaq/cmit/HPMIK.html
- ⁴ HP Client Security Manager Gen7 requires Windows and is available on the select HP PCs.
- ⁵ HP Sure Click requires Windows 11 Pro or Enterprise. See https://bit.ly/2PrLT6A_SureClick for complete details.
- ⁶ HP Sure Sense requires Windows 11 Pro or Enterprise and supports Microsoft Internet Explorer, Google Chrome[™], and Chromium[™]. Supported attachments include Microsoft Office (Word, Excel, PowerPoint) and PDF files in read only mode, when Microsoft Office or Adobe Acrobat are installed.
- ⁷ Microsoft Defender Opt in and internet connection required for updates.
- ⁸ HP Sure Start Gen 7 is available on select HP PCs and workstations. See product specifications for availability.
- ⁹ HP Sure Run Gen5 is available on select Windows 11 based HP Pro, Elite and Workstation PCs with select Intel® or AMD processors
- ¹⁰ HP Sure Recover Gen4 is available on select HP PCs and requires Windows 10 and an open network connection. You must back up important files, data, photos, videos, etc. before using HP Sure Recover to avoid loss of data. Network based recovery using Wi-Fi is only available on PCs with Intel Wi-Fi Module



Supported Components

- ¹¹ HP Sure Admin requires Windows 10 or higher, HP BIOS, HP Manageability Integration Kit from http://www.hp.com/go/clientmanagement and HP Sure Admin Local Access Authenticator smartphone app from the Android or Apple store.
- ¹² Enable/disable by customers or IT administrator with administrator authority.
- ¹³ HP BIOSphere Gen6 features may vary depending on the platform and configurations.
- ¹⁶ Secure Erase For the methods outlined in the National Institute of Standards and Technology Special Publication 800-88 "Clear" sanitation method. HP Secure Erase does not support platforms with Intel® Optane.
- ¹⁸ HP Wolf Pro Security Edition is available preloaded on select SKUs, and, depending on the HP product purchased, includes a license with a term length communicated to you at purchase and in your order confirmation email. The HP Wolf Pro Security Edition software is licensed under the license terms of the HP Wolf Security Software End-User license Agreement (EULA) that can be found at: https://support.hp.com/us-en/document/ish_3875769-3873014-16 as that EULA is modified by the following: 7. Term. Unless otherwise terminated earlier pursuant to the terms contained in this EULA, the license for the HP Wolf Pro Security Edition is effective upon 4 months after the date the HP Product was shipped by HP and will continue for the term communicated to you at purchase and in your order confirmation email ("Initial Term"). At the end of the Initial Term you may either (a) purchase a renewal license for the HP Wolf Pro Security Edition from HP.com, HP Sales or an HP Channel Partner, or (b) continue using the standard versions of HP Sure Click and HP Sure Sense at no additional cost with no future software updates or HP Support. Notwithstanding the foregoing, the license shall expire no later than one year after the fixed term of the subject license ends.
- ²² HP Wolf Security for Business requires Windows 10 or 11 Pro higher, includes various HP security features and is available on HP Pro, Elite, RPOS and Workstation products. See product details for included security features.
- ²³ Absolute agent is shipped turned off, and will be activated when customers activate a purchased subscription. Subscriptions can be purchased for terms ranging multiple years. Service is limited, check with Absolute for availability outside the U.S. The Absolute Recovery Guarantee is a limited warranty. Certain conditions apply. For full details visit: http://www.absolute.com/company/legal/agreements/computrace-agreement. Data Delete is an optional service provided by Absolute Software. If utilized, the Recovery Guarantee is null and void. In order to use the Data Delete service, customers must first sign a Pre-Authorization Agreement and either obtain a PIN or purchase one or more RSA SecurID tokens from Absolute Software.
- ²⁴Firmware TPM is version 15.23 and version 7.2.3.1 for Infineon and Nuvoton chips, respectively. Hardware TPM is v2.0.
 ²⁵ HP Services Scan is provided with Windows Update on select products and will check entitlement on each hardware device to determine if an HP TechPulse-enabled service has been purchased, and will download applicable software automatically. HP TechPulse is a telemetry and analytics platform that provides critical data around devices and applications. For full system requirements or to disable this feature, please visit http://www.hpdaas.com/requirements. Not applicable in China.



System Technical Specifications

System Board

System Board Form

Factor

Tower

Processor Socket AMD Socket SP6 AMD PRO 695 Chipset Chipset

Super I/O Controller Nuvoton SIO21

Memory Expansion Slots 8 DDR5 memory slots

Memory Type Supported DDR5 RDIMM (Registered), RDIMMs and 3DS RDIMMs

Memory Modes Memory Speed Supported

5200MT/s DDR5. The memory will run at the slowest supported speed that either the CPU or the memory modules support. For example, if the CPU only supports 5200MHz speed, 5600MHz will only

Non-Interleaving for single channel, Interleaving when multiple channels are populated

run at 5200MHz'

Memory Protection ECC on data

Maximum Memory 1TB when 128GB are available

Memory Configuration

(Supported)

16GB. 32GB. 64GB RDIMMs. 128GB 3DS RDIMMs when available. RDIMMs and 3DS RDIMMs cannot be

mixed in the same system.

NVDIMM Memory N/A

PCI Express Connectors

Standard PCIe Slots:

•4 PCI Express Gen5 slot x16 mechanical/ x16 electrical (full height, full length) • 1 PCI Express Gen4 slot x16 mechanical/x16 electrical (full height, full length) • 1 PCI Express Gen4 slot x4 mechanical/ x4 electrical (full height, half length)

M.2 Slots:

• 2 PCI Express Gen5 slot x4. • 2 PCI Express Gen4 slot x4.

Other PCIe Connections:

• 2 Front NVMe Storage (SlimSAS PCIe Gen4 x8) (each PCIe connection supports two x4 M.2 devices for a total system support of four x4 M.2 devices via QX448)

1 Connector for HP Dual Port 10GbE NIC G2 (PCIe Gen4 x4)

Supported Drive Interfaces

Integrated (2) Serial ATA interfaces (6Gb/s SATA).

On-board RAID Support
Supported on Windows 11

	Factory Configured And Customer Configurable	Customer Configurable Only
AMD Express SATA	N/A	RAID 0 Striped RAID 1 Mirrored
AMD Express NVMe	RAID 0 Striped RAID 1 Mirrored	RAID 5 Striped with Parity RAID 10 Striped and Mirrored

Integrated Graphics None

Network Controller Integrated Realtek RTL8111EPP

Interface: 1GbE RJ-45 Port (10/100/1000Mbps)

Management Capabilities: WOL, PXE, DASH Manageability

External SATA (eSATA)

Serial 1 internal header (requires optional Serial Port Adapter Kit)

2nd Serial Flex IO Module

HD Integrated Audio Yes

USB Connector(s) Front I/O Entry: **Front**

4 USB 3.1 Gen1 Type-A (left-most port supports Battery Charging 1.2)

System Technical Specifications

Front I/O Premium:

1x USB 3.2 Gen2x2 Type-C® (Power Delivery 3.0)

2x USB 3.1 Gen1 Type-A (left-most port supports Battery Charging

1.2)

• USB Type-C® Ports provide 3 Amps @ 5 Volts

• Charging USB Type-A port provides 1.5 Amps @ 5 Volts • Standard USB Type-A Ports provide 900mA @ 5 Volts

4x USB 3.1 Gen1 Type-A with USB hub and 2x USB 3.2 Gen 1 Type-A

without hub.

(Optional: 2x USB 3.0 Type-A (optional via Flex module) or 1x USB 3.1

Gen2 Type-C® charging port (optional via Flex module).

Internal 1 USB 3.2 Gen1 header, with a single 12-pin shrouded connector. This

header supports a USB Media Card reader.

1 USB 2.0 single port header

HD Integrated Audio Yes Flash ROM Yes **CPU Fan Header** Yes

Memory Fan Header Yes

Chassis Fan Header Yes (Rear, Front Upper, Front Lower)

Rear

Front PCI Fan Header Yes (Lower and Upper)

Front Control

Panel/Speaker Header

CMOS Battery Holder -

Lithium

Yes

Yes

Integrated Trusted

Integrated TPM 2.0

Platform Module The TPM module disabled where restricted by law, i.e. Russia.

Power Supply Headers Power Switch, Power LED Yes & Hard Drive LED Header **Clear Password Jumper** Yes

Keyboard/Mouse USB or PS/2 (option)

1450W, 1125W/1275W and 775W **Power Supply**

System Technical Specifications

System Configuratio	ns						
Example Configuration	Processor Info	AMD Ryzen™	Threadripper™	¹ PRO 7945WX	,		
#1	Memory Info	32GB DDR5 (2	2x16GB) RegRA	M			
	Graphics Info	1x NVIDIA® AZ	2000				
	Disks/Optical/Floppy	1x 4TB Intern	al M.2 SSD + 1:	x DVDRW SATA	1		
	PSU	775W					
	Other	N/A					
Energy Consumption		115 VAC		230 VAC		100 VAC	
(Watts)		LAN Enabled	LAN Disabled	LAN Enabled	LAN Disabled	LAN Enabled	LAN Disabled
	Windows Idle (S0)	57.382	56.779	57.761	56.668	TBD	TBD
	Windows Busy Typ (S0)	36	7.6	361.6		364.79	
	Windows Busy Max (S0)	385	5.28	380.22		382.32	
	Sleep (S3)	6.557	6.483	6.976	6.543	6.574	6.492
	Off (S5)	1.969	1.949	2.448	2.059	2.032	1.957
	Zero Power Mode (EuP)	0.247		0.286		0.248	

Heat Dissipation		115 VAC		230 VAC		100 VAC		
(Btu/hr)		LAN	LAN	LAN	LAN	LAN	LAN	
		Enabled	Disabled	Enabled	Disabled	Enabled	Disabled	
	Windows Idle (S0)	195.787	193.729	197.081	193.351	198.506	193.703	
	Windows Busy Typ (S0)	1254	1.251	1233	3.779	1244	1.263	
	Windows Busy Max (S0)	1314	1.576	1297	7.311	1304	1.476	
	Sleep (S3)	22.372	22.120	23.802	22.324	22.430	22.151	
	Off (S5)	6.718	6.650	8.352	7.025	6.933	6.677	
	Zero Power Mode (EuP)	0.8	343	0.9	76	0.8	346	
Example Configuration	Processor Info	AMD Ryzen™ Threadripper™ PRO 7955WX						
#2	Memory Info	64GB DDR5 (4x16GB) RegRAM						
	Graphics Info	1x NVIDIA® A4000						
	Disks/Optical/Floppy	1x 4TB Internal SATA HDD + 2x 4TB Internal M.2 SSD						
	PSU	1125W						
	Other	N/A						
Energy Consumption		115	VAC	230	VAC	100 VAC		
(Watts)		LAN Enabled	LAN Disabled	LAN Enabled	LAN Disabled	LAN Enabled	LAN Disabled	
	Windows Idle (S0)	75.011	72.431	75.639	73.246	74.745	72.687	
	Windows Busy Typ (S0)	533	3.61	526	5.80	535	5.71	
	Windows Busy Max (S0)	605	5.35	588	3.25	606	5.37	
	Sleep (S3)	6.708	6.657	6.825	6.627	6.712	6.664	
	Off (S5)	2.475	2.401	2.512	2.436	2.481	2.406	
	Zero Power Mode (EuP)	0.2	257	0.2	296	0.2	255	

Heat Dissipation	115 VAC		230 VAC		100 VAC	
(Btu/hr)	LAN	LAN	LAN	LAN	LAN	LAN

System Technical Specifications

		Enabled	Disabled	Enabled	Disabled	Enabled	Disabled	
	Windows Idle (S0)	255.938	247.134	258.080	249.915	255.030	248.008	
	Windows Busy Typ (S0)	1820).677	1797	.442	1827	7.843	
	Windows Busy Max (S0)	2065	5.454	2007	'.109	2068.934		
	Sleep (S3)	22.888	22.714	23.287	22.611	22.901	22.738	
	Off (S5)	8.445	8.192	8.571	8.312	8.465	8.209	
	Zero Power Mode (EuP)	3.0	377	1.0)10	0.8	371	
Example Configuration	Processor Info	AMD Ryzen™ Threadripper™ PRO 7975WX						
#3	Memory Info	128GB DDR5 (8x16GB) RegRAM						
	Graphics Info	2x NVIDIA® A4000						
	Disks/Optical/Floppy	2x 1TB Internal SATA HDD + 2x 4TB Internal M.2 SSD + 1x DVDRW SATA						
	PSU	1125W						
	Other	N/A						

Energy Consumption (Watts)		115 VAC		230 VAC		100 VAC	
		LAN Enabled	LAN Disabled	LAN Enabled	LAN Disabled	LAN Enabled	LAN Disabled
	Windows Idle (S0)	108.546	105.36	109.341	105.884	108.451	104.874
	Windows Busy Typ (S0)	716	5.74	700.56		718.32	
	Windows Busy Max (S0)	780.421		759.67		776.841	
	Sleep (S3)	8.295	8.034	8.455	8.237	8.311	8.287
	Off (S5)	2.289	2.271	2.297	2.281	2.288	2.274
	Zero Power Mode (EuP)	0.2	0.231		0.293		0.233

Heat Dissipation		115 VAC		230 VAC		100 VAC	
(Btu/hr)		LAN Enabled	LAN Disabled	LAN Enabled	LAN Disabled	LAN Enabled	LAN Disabled
				l l		1	
	Windows Idle (S0)	370.359	359.489	373.071	361.276	370.035	357.831
	Windows Busy Typ (S0)	2445.516 2390.).311	2450	.908	
	Windows Busy Max (S0)	2662.796		2591.994		2650.581	
	Sleep (S3)	28.302	27.412	28.848	28.105	28.357	28.275
	Off (S5)	7.811	7.748	7.837	7.783	7.806	7.759
	Zero Power Mode (EuP)	0.7	88	0.999		0.794	

Example Configuration	Processor Info	AMD Ryzen™ Threadripper™ PRO 7995WX
#4	Memory Info	256GB DDR5 (8x32GB) RegRAM
	Graphics Info	2x NVIDIA® A6000
	Disks/Optical/Floppy	2x 4TB Internal SATA HDD + 2x 4TB Internal M.2 SSD
	PSU	1450W/200V
	Other	N/A

Energy Consumption		115 VAC		230 VAC		100 VAC	
(Watts)		LAN Enabled	LAN Disabled	LAN Enabled	LAN Disabled	LAN Enabled	LAN Disabled
	Windows Idle (S0)	N,	/A	179.521	157.249	N,	/A
	Windows Busy Typ (S0)	N/A		N/A 925.96		N/A	

System Technical Specifications

Windows Busy Max (S0)	N	/A	100	3.71	N.	/A
Sleep (S3)	N/A	N/A	10.674	10.514	N/A	
f (S5)	N/A	N/A	2.886	2.871	N/A	l
ro Power Mode (EuP)	TI	BD	0.3	12	N,	/A

Heat Dissipation		115 VAC		230 VAC		100 VAC	
(Btu/hr)		LAN Enabled LAN Disabled		LAN Enabled	LAN Disabled	LAN Enabled	LAN Disabled
	Windows Idle (S0)	N/A		612.526 536.533		N/A	
	Windows Busy Typ (S0)	N/A		3159.376		N/A	
	Windows Busy Max (S0)	N,	/A	3424	1.658	N,	/A
	Sleep (S3)	N/A	N/A	36.419	35.873	N/A	N/A
	Off (S5)	N/A	N/A	9.847	9.795	N/A	N/A
	Zero Power Mode (EuP)	N/A		1.0645		N/A	



System Technical Specifications

Operating Voltage Range 90-269 VAC **Rated Voltage Range** 100-240 VAC **Rated Line Frequency** 50-60 Hz **Operating Line Frequency** 47-66 Hz

Range

ENERGY STAR® certified

(Config Dependent)

FEMP Standby Power

CECP Compliant @ 220V Yes

Compliant

Yes, with Wake-on-LAN disabled: <1W in S5-Power Off

Yes

Built-in Self Test (BIST) LED

Yes

Surge Tolerant Full Ranging Power Supply

(withstands power surges

up to 2000V)

Hood Lock Header Yes ErP Lot 6- Tier 1 Yes Compliance @ 230V (<1W

in S5 - Power Off)

ErP Lot 6- Tier 2 Yes

Compliance @ 230V (<0.5W in S5 - Power Off)

		nd High-end configurations; tested on flo		
System Configuration	Processor Info	AMD Ryzen™ Threadripper™ PRO 794	5WX	
(Entry level)	Memory Info	32GB DDR5 (2x16GB) RegRAM		
	Graphics Info	1x NVIDIA Quadro A2000		
	Disks/Optical	1x 4TB M.2 + 1x DVDRW SATA		
	Power Supply	775W		
Declared Noise Emissions		Sound Power (LWAd, bels)	Deskside Sound Pressure (LpAm, decibels)	
	Idle	3.33	15.9	
(D	Hard drive Operating (Drive Random Seek)	4.10	23.9	
	Active mode	3.94	21.8	
System Configuration	Processor Info	AMD Ryzen™ Threadripper™ PRO 7955WX		
(Mid-level)	Memory Info	64GB DDR5 (4x16GB) RegRAM		
	Graphics Info	1x NVIDIA Quadro A4000		
	Disks/Optical	2x 512GB M.2 SSD + 1x 4TB SATA HDD		
	Power Supply	1125W		
Declared Noise Emissions		Sound Power (LWAd, bels)	Deskside Sound Pressure (LpAm, decibels)	
	Idle	3.51	18.6	
	Hard drive Operating (Drive Random Seek)	4.08	24	

System Technical Specifications

	Active mode	4.55	27.4			
System Configuration	Processor Info	AMD Ryzen™ Threadripper™ PRO 7995WX				
(High-end)	Memory Info	512GB DDR5 (8x64GB) RegRAM				
	Graphics Info	2x NVIDIA Quadro A6000	2x NVIDIA Quadro A6000			
	Disks/Optical	1x 4TB SATA HDD + 4x 4TB M.2 + 1x DVDRW				
	Power Supply	1125W				
eclared Noise Emissions		Sound Power (LWAd, bels)	Deskside Sound Pressure (LpAm, decibels)			
	Idle	3.19	19.1			
	Hard drive Operating (Drive Random Seek)	3.71	22.8			
	Active mode	3.22	19.1			

Envi	ironm	ental
Req	uirem	ents

Temperature Operating: 5° to 40°C (40° to 104°F)¹

Non-operating: -40° to 60°C (-40° to 140°F)

Above 1524 m (5,000 feet) altitude, the maximum operating temperature is reduced by 1° C (1.8° F) for every 305 m (1,000 feet) increase in elevation

Maximum rate of change: 10 °C/hr No direct sustained sunlight

¹40°C has been validated for configs up to a 350W CPU, 2x NVIDIA® RTX A4000 graphics cards, 8x64GB RAM, 4x 4TB M.2 storage, 1x 2TB HDD storage, and 1125W PSU

Humidity

Operating: Operating: 8% to 85% RH, non-condensing, 35° C maximum wet

bulb

Non-operating: 8% to 90% relative humidity, non-condensing, 35° C

maximum wet bulb

Maximum Altitude (non-pressurized)⁶

Operating (with Rotational Hard Drives): 3,048 m (10,000 feet)
Operating (with only Solid-State Drives): 5,000 m (16,404 feet)

Non-operating: 12,192 m (40,000 ft)

NOTE: Above 1524 m (5,000 feet) altitude, maximum operating

temperature is reduced by 1°C (1.8°F) per 305 m (1,000 feet) increase in

elevation.

Dynamic Shock

Operating: ½-sine: 40g, 2-3ms (~62 cm/sec) Non-operating: ½-sine: 160 cm/s, 2-3ms (~105g)

square: 422 cm/s, 20g

NOTE: Values represent individual shock events and do not indicate

repetitive shock events

Vibration

Operating random: 0.5g (rms), 5-300 Hz, up to 0.0025g 2 /Hz Non-operating random: 2.0g (rms), 5-500 Hz, up to 0.0150 g 2 /Hz

NOTE: Values do not indicate continuous vibration.

Cooling

Above 1524 m (5,000 feet) altitude, the maximum operating temperature is reduced by 1° C (1.8° F) for every 305 m (1,000 feet) increase in elevation,

up to 3048 m (10,000 feet)

System Technical Specifications

Physical Security and Serviceability

Access Panel Tool-less

Includes system board and memory information

Optical Drive Tool-less, Optical Drive requires a 5.25" bay carrier

Hard Drives Tool-less **Expansion Cards** Tool-less

Screw-in Retention for Processor and Cooler **Processor Socket Blue User Touch Points** Yes, on tool-less internal chassis mechanisms

Color-coordinated Cables Yes

and Connectors

Memory Tool-less **System Board** Screw-in Power and HD LED on Yes Front of Computer

Over-Temp Warning on

Screen

Yes

Dual Function Front

Power Switch

Yes, causes a fail-safe power off when held for 4 seconds

Padlock Support Yes (optional): Locks side cover and secures chassis from theft 7.0 mm (0.2756 in) diameter padlock

loop at rear of system

Yes, Kensington Cable Lock (optional): Locks side cover and secures chassis from theft 3 mm x 7 mm **Cable Lock Support**

slot at rear of system

Universal Chassis Clamp

Lock Support

Yes (optional): Locks side cover and locks cables to chassis. Secures chassis from theft and allows multiple units to be chained together when used with optional cable with threaded feature at rear of

system

Solenoid Lock and Hood

Sensor

Yes (optional)

The Solenoid Hood Lock eliminates the need for a physical key by making the chassis lockable through software and a password. You can also lock and unlock the chassis remotely over the network. The

Sensor Kit detects when the access panel has been removed

Rear Port Control Cover No Serial, USB, Audio, Yes Network. Enable/Disable

Port Control

Removable Media

Yes Write/Boot Control

Power-On Password Yes

Setup Password Yes, prevents an unauthorized person from changing the workstation configuration.

3.3V Aux Power LED on

System PCA

Nο

NIC LEDs (integrated) (Green & Amber)

Yes

CPUs and Heatsinks A T-20 Torx screwdriver is needed to remove the cooler and CPU.

Power Supply Diagnostic Yes

LED

Front Power Button

Front Power LED Yes, white (normal), red (fault)

Front Hard Drive Activity Yes, white

Front ODD Activity LED Yes

System Technical Specifications

Internal Speaker Yes System/Emergency ROM Yes

Flash Recovery

Cooling Solutions Air cooled forced convection

Power Supply Fans 80 mm x 80 mm x 25 mm (non-serviceable)

CPU Heatsink Fan 108 mm x 108 mm x 25 mm

Chassis Fan Rear: 120 mm x 120 mm x 38mm 4-wire PWM

Front Upper: 80 mm x 80 mm x 25 mm 4-wire PWM (Option based on System Config) Front Lower: 120 mm x 120 mm x 25 mm 4-wire PWM (Option based on System Config)

Side Panel Upper: Dual 70 mm x 20 mm (Option based on System Config)

Dual 60 mm x 60 mm x 25 mm Blindmate (optional based on configuration)

Side Panel Lower: Dual 80 mm x 80 mm x 20 mm (Option based on System config)

Memory Heatsink Fan HP PC Hardware

ACPI-Ready Hardware

Yes

Diagnostics UEFI
Access Panel Kev Lock

Yes, side panel barrel keylock (optional from the factory only)

Advanced Configuration and Power Management Interface (ACPI).

• Allows the system to wake from a low power mode.

• Controls system power consumption, making it possible to place individual cards and peripherals in a

low-power or powered-off state without affecting other elements of the system.

Integrated Chassis

Handles

Yes, Front handle and dedicated rear recess

Power Supply Requires T15 Torx or flat blade screwdriver

PCI Card Retention Yes, rear (all), middle (all), front (full-length cards with extender, using Fan and Front Card

Guide Kit)

Flash ROM Yes

Diagnostic Power Switch Yes

LED on board

Clear Password JumperYesClear CMOS ButtonYesCMOS Battery HolderYesDIMM ConnectorsYes

Service, Support, and Warranty

On-site Warranty and Service¹: Three-years, limited warranty and service offering delivers on-site, next business-day² service for parts and labor. 24/7 operation will not void the HP warranty. Storage devices are not covered under warranty for 24/7 operation except for Enterprise class HDDs.

NOTE 1: Terms and conditions may vary by country. Certain restrictions and exclusions apply.

NOTE 2: On-site service may be provided pursuant to a service contract between HP and an authorized HP third-party provider, and is not available in certain countries. Global service response times are based on commercially reasonable best effort and may vary by country.

HP Care Pack Services extend service contracts beyond the standard warranties. Service starts from date of hardware purchase. To choose the right level of service for your HP product, use the HP Care Pack Services Lookup Tool at: http://www.hp.com/go/lookuptool. Service levels and response times for HP Care Packs may vary depending on your geographic location.

Certification and Compliance



System Technical Specifications

- USGv6 compliant for Windows OS (USGv6 Compliance Report)
- Completed ISO/IEC 17025 accredited testing designed specifically for the USGv6 Test Program. USGv6 is a test program
 designated by NIST that provides a proof of compliance to IPv6 (Internet Protocol version 6) specifications outlined in
 current industry standards for common network products. It is meant as a strategic planning guide for USG (United States
 Government) IT acquisitions to help ensure the completeness, correctness, interoperability and security of early IPv6
 product offerings so as to protect early USG investments in the technology. (source: UNH)

Environmental Sustainability questions concerning:

- Ecolabels (EPEAT, TCO, etc.)
- ENERGY STAR, California Energy Commission (CEC)
- Compliance with Environmental legislation (EU ErP, China CECP, EU RoHS and other countries)
- Supply Chain Social Environmental Responsibility (SER) (conflict minerals; human rights, etc.)
- Product specific environmental features (material content, packaging content, recycled content, etc.)
- China Energy Label (CEL)

Please contact sustainability@hp.com

For country specific Regulatory Compliance approval documents or Regulatory and Safety questions concerning:

- Declarations of Conformity (for self-service, go to https://www.hp.com/uk-en/certifications/technical/regulations-certificates.html?jumpid=ex_r135_uk/en/any/corp/hpuk-mu_chev/certificates)
- GS Certificates
- Product Safety Certificates (UL, CB, BIS, etc.)
- EMC Certificates, Declarations of Conformity, or Certificates of Conformity (CE, FCC, ICES, etc.)
- CCC Certificates
- Ergonomics

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Please contact techreqshelp@hp.com

BIOS

PCIe 5.0 Support Full BIOS support for PCI Express through industry standard interfaces. Supported speeds and slot

information vary.

ATA/ATAPI AT Attachment 6 with Packet Interface (ATA/ATAPI-6), Revision 3b

WMI Support WMI is Microsoft's implementation of Web-Based Enterprise Management (WBEM) for Windows. WMI is

fully compliant with the Distributed Management Task Force (DMTF) Common Information Model (CIM)

and WBEM specifications.

BIOS Power On Users can define a specific date and time for the system to power on.

ROM Based Computer Review and customize system configuration settings controlled by the BIOS.

Setup Utility (F10)

System/Emergency ROM Recovers system BIOS in corrupted Flash ROM.

Flash Recovery with

Video

AMD ROM Armor v3 AMD Platform Secure Processor enforced BIOS ROM access.

AMD Transparent Secure Memory Encryption

Physical encryption of all system memory decoupled from the Operating System. Provides encryption without requiring software modification.

(TSME)
Replicated Setup

Saves BIOS settings to USB flash device in human readable file (HpSetup.txt).

BiosConfigurationUtility.exe utility can then replicate these settings on machines being deployed

without entering Computer Configuration Utility (F10 Setup). System Management BIOS Reference Specification, Version 3.5

Boot Control Disables the ability to boot from removable media on supported devices.

Memory Change Alert Alerts management console if memory is removed or changed.

Thermal Alert Monitors the temperature state within the chassis. Three modes:



SMBIOS

System Technical Specifications

• NORMAL - normal temperature ranges.

 ALERTED - excessive temperatures are detected. Raises a flag so action can be taken to avoid shutdown or provide for a smoother system shutdown.

• SHUTDOWN - excessive temperatures are encountered. Automatically shuts down the computer

without warning before hardware component damage occurs.

Remote ROM Flash **ACPI (Advanced**

Provides secure, fail-safe ROM image management from a central network console. Allows the system to enter and resume from low power modes (sleep states).

Management Interface)

Configuration and Power Enables an operating system to control system power consumption based on the dynamic workload. Makes it possible to place individual cards and peripherals in a low-power or powered-off state without

affecting other elements of the system.

Supports ACPI 6.0 for full compatibility with 64-bit operating systems.

Ownership Tag Shutdown

A user-defined string stored in non-volatile memory that is displayed in the BIOS splash screen. **Remote Wakeup/Remote** System administrators can power on, restart, and power off a client computer from a remote location.

Instantly Available PC (Suspend to RAM - ACPI sleep state S3)

Allows for very low power consumption with guick resume time.

Remote System

Installation via F12 (PXE operating system. 2.1) (Remote Boot from

Allows a new or existing system to boot over the network and download software, including the

Server)

ROM revision levels

Reports the system BIOS revision level in Computer Configuration Utility (F10 Setup). Version is available through an industry standard interface (SMBIOS and WMI) so that management SW

applications can use and report this information.

System board revision

Start-up Diagnostics

level

Revision level is digitally encoded into the HW and cannot be modified. Assesses system health at boot time with selectable levels of testing.

Allows management SW to read revision level of the system board.

(Power-on Self-Test) Auto Setup when new hardware installed

System automatically detects addition of new hardware.

Keyboard-less Operation The system can be booted without a keyboard.

Localized ROM Setup

Common BIOS image supports System Configuration Utility (F10 Setup) menus in 15 languages with

local keyboard mappings.

Asset Tag

The user or MIS to set a unique tag string in non-volatile memory.

Per-slot Control

Allows I/O slot parameters (option ROM enable/disable, bifurcation, speed) to be configured

individually.

Adaptive Cooling **Pre-boot Diagnostics** Control parameters are set according to detected hardware configuration for optimal acoustics.

(Pre-video) critical errors are reported via beeps and blinks on the power LED.

UEFI Specification

2.7

Revision

ACPI Advanced Configuration and Power Management Interface, Version 6.0

CD Boot "El Torito" Bootable CD-ROM Format Specification Version 1.0

Enhanced Host Controller Interface for Universal Serial Bus, Revision 1.0 EHCI

PCI Express PCI Express Base Specification, Revision 2.0

PCI Express Base Specification, Revision 3.0 PCI Express Base Specification, Revision 4.0 PCI Express Base Specification, Revision 5.0

SATA Serial ATA Specification, Revision 1.0a

> Serial ATA 3 Gb/s: Serial ATA Specification, Revision 2.5 Serial ATA 6 Gb/s: Serial ATA Specification, Revision 3.0

SPD JEDEC JESD300-5

TPM Trusted Computing Group TPM Specification Version 2.0 (Infineon SLB 9672).

Common Criteria EAL4+ certified.



System Technical Specifications

FIPS 140-2 Certification

TCG TPM Certified products list:

http://www.trustedcomputinggroup.org/certification/tpm-certified-products/

UHCI Universal Host Controller Interface Design Guide, Revision 1.1

Universal Serial Bus Revision 1.1 Specification Universal Serial Bus Revision 2.0 Specification Universal Serial Bus Revision 3.1 Specification Universal Serial Bus Revision 3.2 Specification USB Battery Charging specification, Revision 1.2 USB Power Delivery specification Revision 3.0

Social and Environmental Responsibility

Eco-Label Certifications & Declarations

USB

This product is low halogen except for configurations that include the Broadcom 5720-2P NIC card.

This product has received or is in the process of being certified to the following approvals and may be labeled with one or more of these marks:

- IT ECO declaration
- US ENERGY STAR®
- US Federal Energy Management Program (FEMP)
- EPEAT® Gold with Climate+ registered. See www.epeat.net for registration status and tier levels by country
- TCO or TCO Certified Edge: certified in all markets except North America
- China Energy Conservation Program (CECP)
- China State Environmental Protection Administration (SEPA)
- Taiwan Green Mark
- Korea Eco-label
- Japan PC Green label*

Sustainable Impact Specifications

- Product Carbon Footprint
- Ocean-bound plastic in system fan, CPU fan¹
- 35% post-consumer recycled plastic²
- 10% recycled metal⁷
- Low halogen³
- Outside Box and corrugated cushions are 100% sustainably sourced and recyclable⁴
- Recycled Plastic cushions^{5,6}.

System Configuration

The configuration used for the Energy Consumption and Declared Noise Emissions data for the Notebook model is based on a "Typically Configured Notebook".

Energy Consumption (in accordance with US ENERGY STAR® test

method)	115VAC, 60Hz	230VAC, 50Hz	100VAC, 50Hz
Normal Operation (Sort idle)	71.717 W	70.346 W	70.622 W
Normal Operation (Long idle)	69.41 W	68.18 W	68.87 W
Sleep	6.91 W	6.86 W	6.92 W
Off	2.35 W	2.19 W	2.25 W

NOTE:

Energy efficiency data listed is for an ENERGY STAR® compliant product if offered within the model family. HP computers marked with the ENERGY STAR® Logo are compliant with the applicable U.S. Environmental Protection Agency (EPA) ENERGY STAR® specifications for computers. If a model family



System Technical Specifications

does not offer ENERGY STAR® compliant configurations, then energy efficiency data listed is for a typically configured PC featuring a hard disk drive, a high efficiency power supply, and a Microsoft Windows® operating system.

Heat Dissipation*	115VAC, 60Hz	230VAC, 50Hz	100VAC, 50Hz
Normal Operation (Short idle)	245.27 BTU/hr	240.58 BTU/hr	241.53 BTU/hr
Normal Operation (Long idle)	237.40 BTU/hr	233.19 BTU/hr	235.55 BTU/hr
Sleep	23.66 BTU/hr	23.46 BTU/hr	23.67 BTU/hr
Off	8.0 BTU/hr	7.49 BTU/hr	7.70 BTU/hr

*NOTE: Heat dissipation is calculated based on the measured watts, assuming the service level is attained for one hour.

Declared Noise Emissions (in accordance with ISO 7779 and ISO 9296)	Sound Power (L _{WAd} , bels)	Sound Pressure (L _{pAm} , decibels)
Typically Configured – Idle	3.33	15.9
Fixed Disk – Drive Random Seek	4.1	23.9
Optical Drive – Active Mode	3.94	21.8

Longevity and Upgrading

This product can be upgraded, possibly extending its useful life by several years. Upgradeable features and/or components contained in the

Spare parts are available throughout the warranty period and or for up to "5" years after the end of production.

Additional Information

- This product is in compliance with the Restrictions of Hazardous Substances (RoHS) directive -2011/65/EC.
- This HP product is designed to comply with the Waste Electrical and Electronic Equipment (WEEE) Directive – 2002/96/EC.
- This product is in compliance with California Proposition 65 (State of California; Safe Drinking Water and Toxic Enforcement Act of 1986).
- This product is in compliance with the IEEE 1680 (EPEAT) standard at the Gold level, see www.epeat.net
- Plastics parts weighing over 25 grams used in the product are marked per ISO11469 and ISO1043.
- This product is 94.6% recycle-able when properly disposed of at end of life.

Packaging Materials	External:	PAPER/Corrugated	1560 g
		PAPER/Paperboard	70 g
	Internal:	PLASTIC/EPE (Expanded Polyethylene)	636 g
		PLASTIC/Polyethylene low density - LDPE	50 g

The plastic packaging material contains at least 92.7% recycled content.

The corrugated paper packaging materials contains at least 35% recycled content.

RoHS Compliance

HP Inc. complies fully with materials regulations. We were among the first companies to extend the restrictions in the European Union (EU) Restriction of Hazardous Substances (RoHS) Directive to our products worldwide through the HP GSE. HP has contributed to the development of related legislation in

System Technical Specifications

Europe, as well as China, India, and Vietnam.

We believe the RoHS directive and similar laws play an important role in promoting industry-wide elimination of substances of concern. We have supported the inclusion of additional substances—including PVC, BFRs, and certain phthalates—in future RoHS legislation that pertains to electrical and electronics products.

We met our voluntary objective to achieve worldwide compliance with the new EU RoHS requirements for virtually all relevant products by July 2013, and we will continue to extend the scope of the commitment to include further restricted substances as regulations continue to evolve.

To obtain a copy of the HP RoHS Compliance Statement, see HP RoHS position statement.

Material Usage

This product does not contain any of the following substances in excess of regulatory limits (refer to the HP General Specification for the Environment at

http://www.hp.com/hpinfo/globalcitizenship/environment/pdf/gse.pdf):

- Asbestos
- Certain Azo Colorants
- Certain Brominated Flame Retardants may not be used as flame retardants in plastics
- Cadmium
- Chlorinated Hydrocarbons
- Chlorinated Paraffins
- Bis(2-Ethylhexyl) phthalate (DEHP)
- Benzyl butyl phthalate (BBP)
- Dibutyl phthalate (DBP)
- Diisobutyl phthalate (DIBP)
- Formaldehyde
- Halogenated Diphenyl Methanes
- Lead carbonates and sulfates
- Lead and Lead compounds
- Mercuric Oxide Batteries
- Nickel finishes must not be used on the external surface designed to be frequently handled or carried by the user.
- Ozone Depleting Substances
- Polybrominated Biphenyls (PBBs)
- Polybrominated Biphenyl Ethers (PBBEs)
- Polybrominated Biphenyl Oxides (PBBOs)
- Polychlorinated Biphenyl (PCB)
- Polychlorinated Terphenyls (PCT)
- Polyvinyl Chloride (PVC) except for wires and cables, and certain retail packaging has been voluntarily removed from most applications.
- Radioactive Substances
- Tributyl Tin (TBT), Triphenyl Tin (TPT), Tributyl Tin Oxide (TBTO)

Packaging Usage

HP follows these guidelines to decrease the environmental impact of product packaging:

- Eliminate the use of heavy metals such as lead, chromium, mercury and cadmium in packaging materials.
- Eliminate the use of ozone-depleting substances (ODS) in packaging materials.
- Design packaging materials for ease of disassembly.
- Maximize the use of post-consumer recycled content materials in packaging materials.
- Use readily recyclable packaging materials such as paper and corrugated materials.
- Reduce size and weight of packages to improve transportation fuel efficiency.



System Technical Specifications

• Plastic packaging materials are marked according to ISO 11469 and DIN 6120 standards.

End-of-life Management and Recycling

HP offers end-of-life HP product return and recycling programs in many geographic areas. To recycle your product, please go to: http://www.hp.com/go/reuse-recycle or contact your nearest HP sales office. Products returned to HP will be recycled, recovered or disposed of in a responsible manner.

The EU WEEE directive (2002/95/EC) requires manufacturers to provide treatment information for each product type for use by treatment facilities. This information (product disassembly instructions) is posted on the Hewlett Packard web site at: http://www.hp.com/go/recyclers. These instructions may be used by recyclers and other WEEE treatment facilities as well as HP OEM customers who integrate and re-sell HP equipment.

HP, Inc. Corporate Environmental Information

For more information about HP's commitment to the environment:

Global Citizenship Report

http://www.hp.com/hpinfo/globalcitizenship/gcreport/index.html

Eco-label certifications

http://www8.hp.com/us/en/hp-information/environment/ecolabels.html

ISO 14001 certificates:

http://h20195.www2.hp.com/V2/GetDocument.aspx?docname=c04755842 and

http://www.hp.com/hpinfo/globalcitizenship/environment/pdf/cert.pdf

footnotes

- 1. Percentage of ocean-bound plastic contained in each component varies by product
- 2. Recycled plastic content percentage is based on the definition set in the IEEE 1680.1-2018 standard.
- External power supplies, WWAN modules, power cords, cables and peripherals excluded.
- 4. 100% outer box packaging and corrugated cushions made from sustainably sourced certified and recycled fibers.
- 5. Fiber cushions made from 100% recycled wood fiber and organic materials.
- 6. Plastic cushions are made from >90% recycled plastic.
- 7. Disclaimer: recycled metal is expressed as a percentage of the total weight of the metal according to ISO 14021 definitions for metal parts over 25 grams.

Manageability

Industry Standard Specifications AMD DASH Manageability This product meets the following industry standard specifications for manageability functionality:

DASH 1.2 (via Realtek LAN on motherboard)

Provides AMD DASH Manageability functions and features including: Power Management (on, off, reset, graceful shutdown, sleep and hibernate)

- Support in Max Power Savings (Shutdown and Hibernate Modes)
- Hardware Inventory (includes BIOS)
- Indications and Events Alerting
- Text Redirection (SOL)
- USB Redirection
- KVM Redirection
- Wake-on-LAN (WOL), even with Maximum Power Savings Enabled
- DASH 1.2 compliance

AMD Pro Technology

The HP Z6A G5 supports AMD Pro Technology for its manageability solution.



System Technical Specifications

Remote Manageability Software Solutions

The HP Z6A G5 Workstation is supported on the following remote manageability software consoles:

- Realtek Management Console
- Microsoft System Center Configuration Manager with AMPS plugin.
- AMD Management Console
- DASH CLI Command Line Tool

For questions or support for manageability needs, please visit

http://www.hp.com/go/clientmanagement

Supported

HP Remote System Controller



Technical Specifications - Storage Drives

STORAGE/HARD DRIVES

Performance PCIe SSDs for HP Workstations Z Turbo 512GB 2280 PCIe-4x4 TLC SSD Capacity512GBProtocolPCIeForm FactorM.2ControllerNVMeNAND Type3D TLC

Endurance 300TBW (TB Written)

Reliability 1.5M hours

Rated for 24/7/365

operation

Interface PCI Express 4.0 x4 electrical
Operating Temperature 32° to 158° F (0° to 70° C)

No

Performance Sequential Read up to 6400MB/s*

Sequential Write up to 3400MB/s*
Random Read up to 600K IOPS*
Random Write up to 600K IOPS*

NOTE: For storage drives, GB = 1 billion bytes. TB = 1 trillion bytes. Actual formatted capacity is less. Up to 36GB of system disk (for Windows) is reserved for system recovery software.

Z Turbo 512GB 2280 PCIe-4x4 SED OPAL2 TLC M.2 SSD Capacity 512GB
Protocol PCIe
Form Factor M.2
Controller NVMe
NAND Type 3D TLC

Endurance 300TBW (TB Written)

Reliability 1.5M hours

Rated for 24/7/365

operation

Interface PCI Express 4.0 x4 electrical Operating Temperature 32° to 158° F (0° to 70° C)

Nο

Performance Sequential Read up to 6400MB/s*

Sequential Write up to 3400MB/s*
Random Read up to 600K IOPS*
Random Write up to 600K IOPS*

Self-Encrypting Drive OPAL 2

Support

eti-Eiitiyptilig Diive OPAL

*Actual performance may vary.

NOTE: For storage drives, GB = 1 billion bytes. TB = 1 trillion bytes. Actual formatted capacity is less. Up to 36GB of system disk (for Windows) is reserved for system recovery software.

Z Turbo 1TB 2280 PCIe-4x4 SED OPAL2 TLC M.2 SSD Module
 Capacity
 1TB

 Protocol
 PCIe

 Form Factor
 M.2

 Controller
 NVMe

 NAND Type
 3D TLC

Endurance 400TBW (TB Written)

Reliability 1.5M hours



^{*}Actual performance may vary.

up to 6500MB/s*

QuickSpecs

Technical Specifications - Storage Drives

Rated for 24/7/365

operation

No

Interface PCI Express 4.0 x4 electrical Operating Temperature 32° to 158° F (0° to 70° C)

Performance Sequential Read

Sequential Write up to 5000MB/s*
Random Read up to 800K IOPS*
Random Write up to 800K IOPS*

Self-Encrypting Drive OPAL 2

Support

etr-Entrypting Drive OPAL A

*Actual performance may vary.

NOTE: For storage drives, GB = 1 billion bytes. TB = 1 trillion bytes. Actual formatted capacity is less. Up to 36GB of system disk (for Windows) is reserved for system recovery software.

Z Turbo 1TB 2280 PCIe-4x4 TLC SSD Capacity1TBProtocolPCIeForm FactorM.2ControllerNVMeNAND Type3D TLC

Endurance 400TBW (TB Written)

Reliability 1.5M hours

Rated for 24/7/365

operation

No

Sequential Write

Random Read

Random Write

Interface PCI Express 4.0 x4 electrical Operating Temperature 32° to 158° F (0° to 70° C)

Performance Sequential Read

up to 6500MB/s* up to 5000MB/s* up to 800K IOPS* up to 800K IOPS*

NOTE: For storage drives, GB = 1 billion bytes. TB = 1 trillion bytes. Actual formatted capacity is less. Up to 36GB of system disk (for Windows) is reserved for system recovery software.

Z Turbo 2TB 2280 PCIe-4x4 SED OPAL2 TLC M.2 SSD Capacity2TBProtocolPCIeForm FactorM.2ControllerNVMeNAND Type3D TLC

Endurance 500TBW (TB Written)

Reliability 1.5M hours

Rated for 24/7/365

operation

No

Interface PCI Express 4.0 x4 electrical Operating Temperature 32° to 158° F (0° to 70° C)

Performance Sequential Read up to 6500MB/s*

Sequential Write up to 5000MB/s*

Random Read up to 800K IOPS*

Random Write up to 800K IOPS*

^{*}Actual performance may vary.

Technical Specifications - Storage Drives

Self-Encrypting Drive

OPAL 2

Support

*Actual performance may vary.

NOTE: For storage drives, GB = 1 billion bytes. TB = 1 trillion bytes. Actual formatted capacity is less. Up to 36GB of system disk (for Windows) is reserved for system recovery software.

Z Turbo 2TB 2280 PCIe-4x4 TLC SSD Capacity2TBProtocolPCIeForm FactorM.2ControllerNVMeNAND Type3D TLC

Endurance 500TBW (TB Written)

No

Reliability 1.5M hours

Rated for 24/7/365

operation Interface

PCI Express 4.0 x4 electrical rature 32° to 158° F (0° to 70° C)

Operating Temperature
Performance

Sequential Read up to 6500MB/s*
Sequential Write up to 5000MB/s*
Random Read up to 800K IOPS*
Random Write up to 800K IOPS*

NOTE: For storage drives, GB = 1 billion bytes. TB = 1 trillion bytes. Actual formatted capacity is less. Up to 36GB of system disk (for Windows) is reserved for system recovery software.

Z Turbo 4TB 2280 PCIe-4x4 TLC M.2 SSD
 Capacity
 4TB

 Protocol
 PCIe

 Form Factor
 M.2

 Controller
 NVMe

 NAND Type
 3D TLC

Endurance 600TBW (TB Written)

Reliability 1.5M hours

Rated for 24/7/365

operation

No

InterfacePCI Express 4.0 x4 electricalOperating Temperature32° to 158° F (0° to 70° C)

Performance Sequential Read up to 6500MB/s*

Sequential Write up to 5000MB/s*
Random Read up to 700K IOPS*
Random Write up to 700K IOPS*

NOTE: For storage drives, GB = 1 billion bytes. TB = 1 trillion bytes. Actual formatted capacity is less. Up to 36GB of system disk (for Windows) is reserved for system recovery software.

Z Turbo 4TB 2280 PCIe-4x4 SED OPAL2 TLC M.2 SSD Capacity4TBProtocolPCIeForm FactorM.2ControllerNVMeNAND Type3D TLC



^{*}Actual performance may vary.

^{*}Actual performance may vary.

Technical Specifications - Storage Drives

Endurance 600TBW (TB Written)

Reliability 1.5M hours

Rated for 24/7/365

operation

Interface PCI Express 4.0 x4 electrical Operating Temperature 32° to 158° F (0° to 70° C)

Nο

Performance Sequential Read up to 6500MB/s*

Sequential Writeup to 5000MB/s*Random Readup to 700K IOPS*Random Writeup to 700K IOPS*

Self-Encrypting Drive OPAL 2

Support

NOTE: For storage drives, GB = 1 billion bytes. TB = 1 trillion bytes. Actual formatted capacity is less. Up to 36GB of system disk (for Windows) is reserved for system recovery software.

Performance PCIe SSDs for HP Quad Pro Carrier

HP Z Turbo Drive Ouad Pro 512GB SSD

 Capacity
 512GB

 Protocol
 PCIe

 Form Factor
 M.2

 Controller
 NVMe

 NAND Type
 3D TLC

Endurance 300TBW (TB Written)

Reliability 1.5M hours

Rated for 24/7/365

operation

Interface PCI Express 4.0 x4 electrical
Operating Temperature 32° to 158° F (0° to 70° C)

Nο

Performance Sequential Read up to 6400MB/s*

Sequential Write up to 3400MB/s*
Random Read up to 600K IOPS*
Random Write up to 600K IOPS*

NOTE: For storage drives, GB = 1 billion bytes. TB = 1 trillion bytes. Actual formatted capacity is less. Up to 36GB of system disk (for Windows) is reserved for system recovery software.

HP Z	Turb	o D	rive
Quad	Pro	1 T I	B SSD

Capacity1TBProtocolPCIeForm FactorM.2ControllerNVMeNAND Type3D TLC

Endurance 400TBW (TB Written)

Reliability 1.5M hours

Rated for 24/7/365

operation

Interface PCI Express 4.0 x4 electrical Operating Temperature 32° to 158° F (0° to 70° C)

No

Performance Sequential Read up to 6500MB/s*

Sequential Write up to 5000MB/s*

^{*}Actual performance may vary.

^{*}Actual performance may vary.

Technical Specifications - Storage Drives

Random Read up to 800K IOPS*
Random Write up to 800K IOPS*

NOTE: For storage drives, GB = 1 billion bytes. TB = 1 trillion bytes. Actual formatted capacity is less. Up to 36GB of system disk (for Windows) is reserved for system recovery software.

HP	Z	Γurb	0	Dr	ive
0u	ad	Pro	2	ΤВ	SSD

Capacity	2TB
Protocol	PCle
Form Factor	M.2
Controller	NVMe
NAND Type	3D TLC

Endurance 500TBW (TB Written)

Reliability 1.5M hours

Rated for 24/7/365

operation

Interface PCI Express 4.0 x4 electrical Operating Temperature 32° to 158° F (0° to 70° C)

Nο

Performance

Sequential Read up to 6500MB/s*
Sequential Write up to 5000MB/s*
Random Read up to 800K IOPS*

Random Write up to 800K IOPS*

NOTE: For storage drives, GB = 1 billion bytes. TB = 1 trillion bytes. Actual formatted capacity is less. Up to 36GB of system disk (for Windows) is reserved for system recovery software.

HP Z Turbo Drive
Quad Pro 4TB SSD

Capacity	4TB
Protocol	PCIe
Form Factor	M.2
Controller	NVMe
NAND Type	3D TLC

Endurance 500TBW (TB Written)

Reliability 1.5M hours

Rated for 24/7/365

operation

Interface PCI Express 4.0 x4 electrical

Nο

Operating Temperature 32° to 158° F (0° to 70° C)
Performance Sequential Read

Sequential Read up to 6500MB/s*
Sequential Write up to 5000MB/s*
Random Read up to 800K IOPS*
Random Write up to 800K IOPS*

NOTE: For storage drives, GB = 1 billion bytes. TB = 1 trillion bytes. Actual formatted capacity is less. Up to 36GB of system disk (for Windows) is reserved for system recovery software.

Performance PCIe SSDs for HP Dual Pro Carrier

HP Z Turbo Drive Dual Pro 512GB SSD

Capacity512GBProtocolPCIeForm FactorM.2ControllerNVMe

^{*}Actual performance may vary.

^{*}Actual performance may vary.

^{*}Actual performance may vary.

Technical Specifications - Storage Drives

3D TLC NAND Type

Endurance 300TBW (TB Written)

Reliability 1.5M hours

Rated for 24/7/365

operation

PCI Express 4.0 x4 electrical

Interface **Operating Temperature** 32° to 158° F (0° to 70° C)

No

Performance Sequential Read up to 6400MB/s*

> **Sequential Write** up to 3400MB/s* **Random Read** up to 600K IOPS* **Random Write** up to 600K IOPS*

NOTE: For storage drives, GB = 1 billion bytes. TB = 1 trillion bytes. Actual formatted capacity is less. Up to 36GB of system disk (for Windows) is reserved for system recovery software.

HP Z	Turbo	Drive
Dual	Pro 11	TB SSD

1TB Capacity PCle Protocol **Form Factor** M.2 Controller NVMe **NAND Type** 3D TLC

Endurance 400TBW (TB Written)

Reliability 1.5M hours

Rated for 24/7/365

operation

No

Interface PCI Express 4.0 x4 electrical **Operating Temperature** 32° to 158° F (0° to 70° C)

Performance Sequential Read

up to 6500MB/s* Sequential Write up to 5000MB/s* **Random Read** up to 800K IOPS* **Random Write** up to 800K IOPS*

NOTE: For storage drives, GB = 1 billion bytes. TB = 1 trillion bytes. Actual formatted capacity is less. Up to 36GB of system disk (for Windows) is reserved for system recovery software.

HP Z	Turbo	Drive
Dual	Pro 21	TB SSD

Capacity 2TB **Protocol PCIe Form Factor** M.2 **Controller** NVMe **NAND Type** 3D TLC

Endurance 500TBW (TB Written)

Reliability 1.5M hours

Rated for 24/7/365

operation

No

Interface PCI Express 4.0 x4 electrical **Operating Temperature** 32° to 158° F (0° to 70° C)

Performance

Sequential Read Sequential Write up to 5000MB/s* **Random Read** up to 800K IOPS*

up to 6500MB/s*

^{*}Actual performance may vary.

^{*}Actual performance may vary.

Technical Specifications - Storage Drives

Random Write up to 800K IOPS*

*Actual performance may vary.

NOTE: For storage drives, GB = 1 billion bytes. TB = 1 trillion bytes. Actual formatted capacity is less. Up to 36GB of system disk (for Windows) is reserved for system recovery software.

ΗP	Z	Turl	bo	Dı	rive
Du	al	Pro	4 T	B	SSD

Capacity 4TB **Protocol** PCIe **Form Factor** M.2 Controller NVMe NAND Type 3D TLC

Endurance 500TBW (TB Written)

Reliability 1.5M hours

Rated for 24/7/365

operation

Interface PCI Express 4.0 x4 electrical **Operating Temperature** 32° to 158° F (0° to 70° C)

No

Performance

Sequential Read up to 6500MB/s* **Sequential Write** up to 5000MB/s* **Random Read** up to 800K IOPS* **Random Write** up to 800K IOPS*

NOTE: For storage drives, GB = 1 billion bytes. TB = 1 trillion bytes. Actual formatted capacity is less. Up to 36GB of system disk (for Windows) is reserved for system recovery software.

SATA Hard Drives for HP Workstations

1TB	7200I	RPM	SATA	3.5in
Ente	erprise	e HD	D	

Capacity 1TB **Protocol** SATA **Form Factor** 3.5" Controller AHCI Reliability 2.0M hours 8760/vr **Rated Power On Hours Annualized Failure Rate** <0.62% (based on Rated POH)

Rated for 24/7/365

operation

YES

Height 1 in: 2.54 cm

Width **Media Diameter** 3.5 in; 8.9 cm

Up to 600MB/s *

Physical Size 4 in; 10.17 cm

Interface Serial ATA (6.0Gb/s), NCQ enabled

Synchronous Transfer

Rate (Maximum)

Buffer 128MB Cache Adaptive

Seek Time (typical reads, Single Track 0.32 ms * includes controller 7.45 ms * Average overhead, including **Full Stroke** 14.2 ms * settling)

Rotational Speed 7,200 rpm **Logical Blocks** 1,953,525,168

^{*}Actual performance may vary.

Technical Specifications - Storage Drives

Operating Temperature 41° to 131° F (5° to 55° C)

Performance Sequential Read up to 226MB/s*
Sequential Write up to 226MB/s*

*Actual performance may vary.

NOTE: For storage drives, GB = 1 billion bytes. TB = 1 trillion bytes. Actual formatted capacity is less. Up to 36GB of system disk (for Windows) is reserved for system recovery software.

2TB

2TB 7200RPM SATA 3.5in Capacity Enterprise HDD Protocol

Protocol SATA

Form Factor 3.5"

Controller AHCI

Reliability 2.0M hours

Rated Power On Hours 8760/yr

Annualized Failure Rate <0.62%

(based on Rated POH)

Rated for 24/7/365 YES

operation

Height 1 in; 2.54 cm

Width Media Diameter 3.5 in; 8.9 cm
Physical Size 4 in; 10.17 cm

Interface Serial ATA (6.0Gb/s), NCQ enabled

Synchronous Transfer

Rate (Maximum)

Up to 600MB/s *

Buffer 128MB Cache Adaptive

Seek Time (typical reads,
includes controller
overhead, including
settling)Single Track
Average0.7 ms *Average
Full Stroke8.5 ms *15.7 ms *

Rotational Speed 7,200 rpm **Logical Blocks** 3,907,029,168

Operating Temperature 41° to 131° F (5° to 55° C)

Performance Sequential Read up to 226MB/s*
Sequential Write up to 226MB/s*

NOTE: For storage drives, GB = 1 billion bytes. TB = 1 trillion bytes. Actual formatted capacity is less. Up to 36GB of system disk (for Windows) is reserved for system recovery software.

4TB 7200 RPM SATA 3.5in Capacity Enterprise HDD Protocol

Capacity4TBProtocolSATAForm Factor3.5"ControllerAHCI

Reliability 2.0M hours
Rated Power On Hours 8760/yr
Annualized Failure Rate <0.62%

(based on Rated POH)

Rated for 24/7/365

operation

Height 1 in; 2.54 cm

YES



^{*}Actual performance may vary.

Technical Specifications - Storage Drives

Media Diameter	3.5 in; 8.9 cm
Physical Size	4 in; 10.17 cm
Serial ATA (6.0Gb/s), NO	Q enabled
Up to 600MB/s *	
256MB	
Adaptive	
Single Track	0.7 ms *
Average	8.5 ms *
Full Stroke	15.7 ms *
7,200 rpm	
7,814,037,168	
41° to 131° F (5° to 55°	C)
Sequential Read	up to 226MB/s*
Sequential Write	up to 226MB/s*
	Physical Size Serial ATA (6.0Gb/s), NO Up to 600MB/s * 256MB Adaptive Single Track Average Full Stroke 7,200 rpm 7,814,037,168 41° to 131° F (5° to 55° Sequential Read

^{*}Actual performance may vary.

NOTE: For storage drives, GB = 1 billion bytes. TB = 1 trillion bytes. Actual formatted capacity is less. Up to 36GB of system disk (for Windows) is reserved for system recovery software.

8TB

8TB	7200RPM SATA 3.5in
Fnte	ernrise HNN

Protocol	SATA
Form Factor	3.5"
Controller	AHCI
Reliability	2.0M hours
Rated Power On Hours	8760/yr
Annualized Failure Rate	<0.62%
(based on Rated POH)	

Rated for 24/7/365

operation

Capacity

Height 1 in; 2.54 cm

Width Media Diameter 3.5 in; 8.9 cm
Physical Size 4 in; 10.17 cm

Up to 600MB/s *

Interface Serial ATA (6.0Gb/s), NCQ enabled

YES

Synchronous Transfer

Rate (Maximum)

Buffer 256MB Cache Adaptive

Seek Time (typical reads,
includes controller
overhead, including
settling)Single Track
Average0.7 ms *Average
Full Stroke8.5 ms *15.7 ms *

Rotational Speed 7,200 rpm Logical Blocks 15,628,053,168

Operating Temperature 41° to 140° F (5° to 60° C)

Performance Sequential Read up to 226MB/s*
Sequential Write up to 226MB/s*



^{*}Actual performance may vary.

Technical Specifications - Storage Drives

NOTE: For storage drives, GB = 1 billion bytes. TB = 1 trillion bytes. Actual formatted capacity is less. Up to 36GB of system disk (for Windows) is reserved for system recovery software.

12TB 7200 RPM SATA-6G Capacity
3.5in Enterprise HDD Protocol

Capacity 12TB
Protocol SATA
Form Factor 3.5"
Controller AHCI
Reliability 2.0M hours
Rated Power On Hours 8760/yr
Annualized Failure Rate <0.62%

(based on Rated POH)

Rated for 24/7/365

operation

Height 1 in; 2.54 cm

Width Media Diameter 3.5 in; 8.9 cm

Up to 600MB/s *

Physical Size 4 in; 10.17 cm

0.7 ms *

8.5 ms *

15.7 ms *

Interface Serial ATA (6.0Gb/s), NCQ enabled

YFS

 ${\bf Synchronous\ Transfer}$

Rate (Maximum)

Rotational Speed

Buffer 256MB Cache Adaptive

Seek Time (typical reads, includes controller overhead, including

settling)

7,200 rpm 23,437,770,752

Full Stroke

Logical Blocks 23,437,770,752 **Operating Temperature** 41° to 140° F (5° to 60° C)

Performance Sequential Read up to 226MB/s*
Sequential Write up to 226MB/s*

NOTE: For storage drives, GB = 1 billion bytes. TB = 1 trillion bytes. Actual formatted capacity is less. Up to 36GB of system disk (for Windows) is reserved for system recovery software.

^{*}Actual performance may vary.

Technical Specifications - Graphics

GRAPHICS

NVIDIA® A800 48GB Form Factor Full-Height Dual Slot (4.4" Height x 10.5" Length)

> Max Power Consumption 240W 40GB HBM2 **GPU Memory**

> > Memory Bandwidth: 1,555 GB/s

Memory Width: 5,120-bit

Connectors **NVLink**

Requires: 1x 16-pin CEM 5 power connector (adapter may be needed)

Not supported - No display out **Maximum Resolution**

Bus Type PCI Express 4.0 x16

Available Graphics Windows 10

Drivers Windows 11

NVIDIA® RTX™ 6000 Ada Form Factor **48GB**

Full-Height Dual Slot (4.4" Height x 10.5" Length)

Weight: 1230 grams / 2.71 lbs (with extender)

Max Power Consumption Power: 300 Watts

Cooling: Active

48GB GDDR6 memory ECC **GPU Memory**

Memory Bandwidth: Up to 960 GB/s

Memory Width: 384 bits

Connectors 4x DisplayPort 1.4a

Quadro Sync II connector

Stereo Sync

Requires CEM 5.0 16-pin auxiliary power adapter

Maximum Resolution 7680x4320 @ 120Hz

Bus Type PCI Express 4.0 x16

Available Graphics

Drivers Windows 10

Linux® 64-bit

Windows 11

AMD® Radeon™ Pro W7900 48GB

Form Factor Full-Height Triple Slot (4.4" Height x 10.5" Length)

Max Power Consumption Power: 295W

Cooling: Active

48GB GDDR6 memory **GPU Memory**

Memory Bandwidth: Up to 864 GB/s

Memory Width: 384 bit

Connectors 3x DisplayPort 2.1

1x Enhanced Mini DisplayPort 2.1

Requires 2x 8-pin auxiliary power connectors

Maximum Resolution

12288x6912 @ 120Hz Bus Type PCI Express 4.0 x16

Available Graphics

Windows 11

Drivers Windows 10

Linux® 64-bit

NVIDIA® RTX™ 5000 Ada Form Factor Full-Height Dual Slot (5.0" Height x 13.85" Length)

Technical Specifications - Graphics

Weight: 1130 grams / 2.49 lbs (excluding extender) **32GB**

> **Max Power Consumption** Power: 250 Watts

Cooling: Active

GPU Memory 32GB GDDR6 memory ECC

Memory Bandwidth: Up to 576 GB/s

Memory Width: 256 bits

Connectors 4x DisplayPort 1.4a

Quadro Sync II connector

Stereo Sync

Requires CEM 5.0 16-pin auxiliary power adapter

Maximum Resolution 7680x4320 @ 120Hz **Bus Type** PCI Express 4.0 x16

Available Graphics

Drivers

Windows 11 Windows 10 Linux® 64-bit

NVIDIA® RTX 4500 Ada **24GB**

Form Factor Full-Height Dual Slot (4.4" Height x 10.5" Length)

Max Power Consumption 210W

GPU Memory 24GB GDDR6

Memory Bandwidth: 432 GB/s

Memory Width: 192-bit

4x DisplayPort 1.4a **Connectors**

Requires: 1x 16-pin CEM 5 power connector (adapter may be needed)

Maximum Resolution 4x @ 4096 x 2160 @ 120Hz

4x @ 5120 x 2880 @ 60Hz 2x @ 7680 x 4320 @ 60Hz

Bus Type PCI Express 4.0 x16

Available Graphics

Drivers

Windows 10 Windows 11

NVIDIA® RTX A4500 20GB

Full-Height Dual Slot (4.4" Height x 10.5" Length) **Form Factor**

Weight: 1049 grams + 80 grams extender

Max Power Consumption Power: 200W

Cooling: Active

20GB GDDR6 memory **GPU Memory**

Memory Bandwidth: Up to 640 GB/s

Memory Width: 320 bit

4x DisplayPort 1.4a Connectors

Quadro Sync II connector

NVLink® Stereo Sync

Requires 8-pin auxiliary power

Maximum Resolution 7680x4320 @ 120Hz

Bus Type PCI Express 4.0 x16

Available Graphics Windows 11

Drivers Windows 10 Linux® 64-bit

Technical Specifications - Graphics

NVIDIA® RTX 4000 Ada

20GB

Form Factor Full-Height Single Slot (4.4" Height x 11.5" Length)

Max Power Consumption 130W

GPU Memory 20GB GDDR6

Memory Bandwidth: 360 GB/s

Memory Width: 160-bit

Connectors 4x DisplayPort 1.4a

Requires: 1x 16-pin CEM 5 power connector (adapter may be needed)

Maximum Resolution 4x @ 4096 x 2160 @ 120Hz

4x @ 5120 x 2880 @ 60Hz 2x @ 7680 x 4320 @ 60Hz

Bus Type PCI Express 4.0 x16

Available Graphics

Drivers

Windows 10 Windows 11

NVIDIA® RTX A4000 16GB

Form Factor

Full-Height Single Slot (4.4" Height x 9.5" Length)

Weight: 500 grams

Max Power Consumption Power: 140W

Cooling: Active

GPU Memory 16GB GDDR6 memory

Memory Bandwidth: Up to 448 GB/s

Memory Width: 256 bit

Connectors 4x DisplayPort 1.4a

Quadro Sync II connector

Stereo Sync

Requires 6-pin auxiliary power

Maximum Resolution

Bus Type

7680x4320 @ 120Hz

Available Graphics

Drivers

PCI Express 4.0 x16

Windows 11

Windows 10 Linux® 64-bit

NVIDIA® RTX™ 2000 Ada Form Factor

16GB

Connectors

Half Height Dual Slot (2.7" Height x 6.7" Length)

Max Power Consumption 70W

GPU Memory 16GB GDDR6

Memory Bandwidth: 224 GB/s

Memory Width: 128-bit

4x Mini DisplayPort 1.4a **Maximum Resolution** 4x 4096 x 2160 @ 120 Hz

> 4x 5120 x 2880 @ 60 Hz 2x 7680 x 4320 @ 60 Hz

Bus Type PCI Express 4.0 x8

Available Graphics Drivers

Windows 10 Windows 11

NVIDIA® RTX A2000

Form Factor

Half-Height Dual Slot (2.713"



Technical Specifications - Graphics

12GB Height x 6.6" Length)

Weight: 306 grams

Max Power Consumption Power: 70W

Cooling: Active

GPU Memory 12GB GDDR6 memory

Memory Bandwidth: Up to 288 GB/s

Memory Width: 192 bit

Connectors4x mini-DisplayPort 1.4aMaximum Resolution7680x4320 @ 120Hz

Bus Type

PCI Express 4.0 x16 Windows 11

Available Graphics Drivers

Windows 10

Linux® 64-bit

NVIDIA® RTX™ A1000 8GB Form Factor

Half Height Single Slot (2.7" Height x 6.4" Length)

Max Power Consumption

GPU Memory

8GB GDDR6

50W

Memory Bandwidth: 192 GB/s

Memory Width: 128-bit

Connectors

4x Mini DisplayPort 1.4a 4x 4096 x 2160 @ 120 Hz

Maximum Resolution 4x 4096 x 2160 @ 120 Hz

4x 5120 x 2880 @ 60 Hz 2x 7680 x 4320 @ 60 Hz

Bus Type PCI Express 4.0 x8

Available Graphics

Drivers

Windows 10 Windows 11

NVIDIA® T1000 8GB

Form Factor Half-Height Single Slot (2.713"

Height x 6.137" Length) Weight: 132.6 grams

Max Power Consumption Power: 50W

Cooling: Active

GPU Memory 8GB GDDR6 memory

Memory Bandwidth: Up to 160 GB/s

Memory Width: 128 bit

Connectors4x mini-DisplayPort 1.4aMaximum Resolution7680x4320 @ 120HzBus TypePCI Express 3.0 x16

Available Graphics

Drivers

Windows 11

Windows 10 Linux® 64-bit

NVIDIA® T400 4GB

Graphics

Form Factor Half-Height Single Slot (2.713"

Height x 6.137" Length) Weight: 123.5 grams

Max Power Consumption Power: 30W

Technical Specifications - Graphics

Cooling: Active

GPU Memory 4GB GDDR6 memory

Memory Bandwidth: Up to 80 GB/s

Memory Width: 64 bit

Connectors 3x mini-DisplayPort 1.4a

Maximum Resolution7680x4320 @ 120HzBus TypePCI Express 3.0 x16

Available Graphics Windows 11

Drivers Windows 10

Linux® 64-bit

AMD® Radeon™ Pro W7900 48GB Form Factor Full-Height Triple Slot (4.38"

Height x 11.0" Length)

Max Power Consumption 295W

GPU Memory 48GB GDDR6

Memory Bandwidth: 864 GB/s Memory Width: 384-bit

Connectors 3x DP 2.1 + 1x Enhanced Mini DP 2.1

Requires: 2x 8-pin PCle Aux Power

Maximum Resolution 4x @ 4096 x 2160 (4K DCI) @ 120Hz with DSC

2x @ 6144 x 3456 (6K) 12-bit HDR @ 60Hz Uncompressed 1x @ 7680 x 4320 (8K) 12-bit HDR @ 60Hz Uncompressed

1x @ 12288 x 6912 (12K) @ 120Hz with DS

Bus Type PCI Express 4.0 x16

Available Graphics

Drivers

Windows 10 Windows 11

NOTE: Not available at launch; available early 2024

AMD® Radeon™ Pro W7600 8GB **Form Factor** Full-Height Single Slot (4.38"

Height x 9.5" Length)

Max Power Consumption 130W

GPU Memory 8GB GDDR6

Memory Bandwidth: 288 GB/s Memory Width: 128-bit

Connectors 4x DP 2.1

Requires: 1x 6-pin PCle Aux Power

Maximum Resolution 4x @ 3840x2160 (4K)

4x @ 5120x2880 (5K) 2x @ 7680x4320 (8K)

Bus Type PCI Express 4.0 x8

Available Graphics Windows 10
Drivers Windows 11

AMD® Radeon™ Pro W7500 8GB Form Factor Full-Height Single Slot (4.38"

Height x 8.5" Length)

Max Power Consumption 70W

GPU Memory 8 GB GDDR6

Memory Bandwidth: 173 GB/s



Technical Specifications - Graphics

Memory Width: 128-bit

Connectors 4x DP 2.1

Maximum Resolution 4x @ 3840x2160 (4K)

> 4x @ 5120x2880 (5K) 2x @ 7680x4320 (8K)

Bus Type PCI Express 4.0 x8

Available Graphics

Windows 10 Windows 11 Drivers

AMD® Radeon™ RX 6400

4GB

Half-Height Single Slot (4.4" Form Factor

Height x 10.5" Length)

Weight: 155 grams

Max Power Consumption Power: 50W

Cooling: Active

4GB GDDR6 memory **GPU Memory**

> Memory Bandwidth: Memory Width:

1x DisplayPort 1.4a **Connectors**

1x HDMI

Maximum Resolution 7680x4320 @ 60Hz

Bus Type PCI Express 4.0 x4

Available Graphics Windows 11 **Drivers**

Windows 10

Linux® 64-bit

Notes for all graphics cards:

- Some graphics and GPU compute cards can consume a great deal of power, thus combinations of cards with other components may exceed a particular power supply's output capability.
- Some graphics and GPU compute cards require supplemental power cables. Not all chassis/PSU configurations have enough supplemental power cables of the correct type for all graphics configurations. Refer to table below for guidance on required power cables based on configured power supply and graphics.

PSU	PSU Aux Power (Graphics)	Graphics Power Adapter/Dongle (spare part number shown below)	Graphics Power Connector (per card)	Max Graphics Card Config
775W	2x PCIe (6+2)-pin	1x N38901-001 - 2x PCle 8-pin to 1x CEM 5.0 16-pin	1x CEM 5.0 16-pin	1x NVIDIA A800 Active
		1x N38901-001 - 2x PCle 8-pin to 1x CEM 5.0 16-pin	1x CEM 5.0 16-pin	1x NVIDIA RTX 6000 Ada
		1x N38901-001 - 2x PCle 8-pin to 1x CEM 5.0 16-pin	1x CEM 5.0 16-pin	1x NVIDIA RTX 5000 Ada
		1x N38901-001 - 2x PCle 8-pin to 1x CEM 5.0 16-pin	1x CEM 5.0 16-pin	1x NVIDIA RTX 4500 Ada
		2x N61947-001 - 1x PCle 8-pin to 1x CEM 5.0 16-pin	1x CEM 5.0 16-pin	2x NVIDIA RTX 4000 Ada
			1x PCle 8-pin	1x NVIDIA RTX A4500
			1x PCle 8-pin	2x NVIDIA RTX A4000
			-	3x NVIDIA RTX A2000
			-	3x NVIDIA T1000
			-	3x NVIDIA T400



Technical Specifications - Graphics

			2x PCIe 8-pin	1x AMD Radeon Pro W7900
			1x PCIe 6-pin	2x AMD Radeon Pro W7600
			-	3x AMD Radeon Pro W7500
			-	1x AMD RX 6400
1125W [1125W (@100V)]	4x PCIe (6+2)-pin Optional: 1x Aux 8-pin	2x N38901-001 - 2x PCle 8-pin to 1x CEM 5.0 16-pin	1x CEM 5.0 16-pin	2x NVIDIA A800 Active
		2x N38901-001 - 2x PCle 8-pin to 1x CEM 5.0 16-pin	1x CEM 5.0 16-pin	2x NVIDIA RTX 6000 Ada
		3x N38901-001 - 2x PCle 8-pin to 1x CEM 5.0 16-pin 1x M78883-001 - Aux 8-pin to 2x PCle (6+2)-pin (3rd)	1x CEM 5.0 16-pin	3x NVIDIA RTX 5000 Ada
		3x N38901-001 - 2x PCle 8-pin to 1x CEM 5.0 16-pin 1x M78883-001 - Aux 8-pin to 2x PCle (6+2)-pin (3rd)	1x CEM 5.0 16-pin	3x NVIDIA RTX 4500 Ada
1275W [1125W		3x N61947-001 - 1x PCle 8-pin to 1x CEM 5.0 16-pin	1x CEM 5.0 16-pin	3x NVIDIA RTX 4000 Ada
(@115V)]			1x PCle 8-pin	3x NVIDIA RTX A4500
			1x PCle 8-pin	3x NVIDIA RTX A4000
			NA .	3x NVIDIA RTX A2000
			NA	3x NVIDIA T1000
			NA	3x NVIDIA T400
			2x PCle 8-pin	1x AMD Radeon Pro W7900
			1x PCle 6-pin	3x AMD Radeon Pro W7600
			NA NA	3x AMD Radeon Pro W7500
			NA	1x AMD RX 6400
1450W [1125W (@200V)]	4x PCIe (6+2)-pin Optional: 1x Aux 8-pin	2x N38901-001 - 2x PCle 8-pin to 1x CEM 5.0 16-pin	1x CEM 5.0 16-pin	2x NVIDIA A800 Active
		3x N38901-001 - 2x PCIe 8-pin to 1x CEM 5.0 16-pin 1x M78883-001 - Aux 8-pin to 2x PCIe (6+2)-pin (3rd)	1x CEM 5.0 16-pin	3x NVIDIA RTX 6000 Ada
		3x N38901-001 - 2x PCle 8-pin to 1x CEM 5.0 16-pin 1x M78883-001 - Aux 8-pin to 2x PCle (6+2)-pin (3rd)	1x CEM 5.0 16-pin	3x NVIDIA RTX 5000 Ada
		3x N38901-001 - 2x PCle 8-pin to 1x CEM 5.0 16-pin 1x M78883-001 - Aux 8-pin to 2x PCle (6+2)-pin (3rd)	1x CEM 5.0 16-pin	3x NVIDIA RTX 4500 Ada
		3x N61947-001 - 1x PCle 8-pin to 1x CEM 5.0 16-pin	1x CEM 5.0 16-pin	3x NVIDIA RTX 4000 Ada
			1x PCle 8-pin	3x NVIDIA RTX A4500
			1x PCle 8-pin	3x NVIDIA RTX A4000
			NA	3x NVIDIA RTX A2000
			NA	3x NVIDIA T1000
			NA	3x NVIDIA T400
			2x PCle 8-pin	1x AMD Radeon Pro W7900
			1x PCle 6-pin	3x AMD Radeon Pro W7600
			NA NA	3x AMD Radeon Pro W7500
			NA	1x AMD RX 6400



Technical Specifications - Optical and Removable Storage

Rates

OPTICAL AND REMOVABLE STORAGE

HP 9.5mm Slim Blu-Ray Writer Description9.5mm height, tray-loadMounting OrientationEither horizontal or vertical

Interface Type SATA/ATAPI

Dimensions (WxHxD) 128 x 9.5 x 127mm

Supported Media Types BD-ROM

BD-R BD-RE DVD+R DVD+RW DVD+R DL DVD-R DL DVD-R DVD-RW CD-R CD-RW

Disc Capacity DVD-ROM 8.5 GB DL or 4.7 GB standard

Blu-ray 25 GB (single-layer)

50 GB (dual-layer) 100/128 GB (BDXL)

Full Stroke DVD < 230 ms (seek)
Full Stroke CD < 220 ms (seek)

Blu-ray< 230 ms (seek) (Full Stroke Blu-ray)</th>Startup Time(Time to drive ready from tray loading)

BD-ROM (SL/DL) 25S / 28S BD-R (SL/DL) 25S / 28S BD-RE (SL/DL) 25S / 28S DVD-ROM (SL/DL) 18S / 18S DVD-R (SL/DL) 25S / 25S

DVD-RW 25S

DVD+R (SL/DL) 25S / 25S

DVD+RW 25S CD-ROM 15S

Maximum Data Transfer CD ROM Read CD-ROM, CD-R Up to 24X

CD-RW Up to 24X

DVD ROM Read DVD+RW Up to 8X

DVD-RW Up to 8X DVD+R DL Up to 8X DVD-R DL Up to 8X DVD-ROM Up to 8X DVD-ROM DL Up to 8X DVD+R Up to 8X DVD-R Up to 8X

Blu-ray BD-ROM Up to 6X

BD-ROM DL Up to 6X
BD-R Up to 6X
BD-R DL Up to 6X
BD-R Up to 6X
BD-RE SL/DL Up to 6X

Technical Specifications - Optical and Removable Storage

Power Source SATA DC power receptacle

DC Power Requirements 5 VDC ± 5%-100 mV ripple p-p **DC Current** 5 VDC -900 mA typical, 2000mA

maximum

Operating Environmental Temperature 41° to 122° F (5° to 50° C)

(all conditions noncondensing)

Relative Humidity 10% to 80% Maximum Wet Bulb 84° F (29° C)

Temperature

Operating Systems
Supported

Windows 11, Windows 10, Windows 7 Professional 64-bit, Red Hat® Enterprise Linux® (RHEL) 8, 9 Desktop/Workstation

SUSE Linux® Enterprise Desktop 15

Ubuntu 20.04, 22.04 LTS

No driver is required for this device. Native support is provided by the

operating system.

Kit Contents 9.5mm Slim BDXL Blu-Ray Writer, 5.25" ODD Bay adapter/carrier, slim

SATA data/power cable, installation guide

As Blu-ray is a new format containing new technologies, certain disc, digital connection, compatibility and/or performance issues may arise, and do not constitute defects in the product. Flawless playback on all systems is not guaranteed. In order for some Blu-ray titles to play, they may require a DVI or HDMI digital connection and your display may require HDCP support. HD-DVD movies cannot be played on this workstation.

NOTE: HD-DVD disks cannot be played on the DVD-ROM drive. No support for DVD-RAM. Actual speeds may vary. Don't copy copyright-protected materials. Double Layer discs can store more data than single layer discs. Discs burned with this drive may not be compatible with many existing single-layer DVD drives and players. Flawless playback on all systems is not guaranteed.

HP 9.5mm Slim DVD Writer **Description** 9.5mm height, tray-load **Mounting Orientation** Either horizontal or vertical

Interface Type SATA/ATAPI

Dimensions (WxHxD) 128 x 9.5 x 127mm

Supported Media Types DVD+R

DVD+RW
DVD+R DL
DVD-R DL
DVD-R
DVD-RW
CD-R
CD-RW

Disc Capacity DVD-ROM 8.5 GB DL or 4.7 GB standard

Full Stroke DVD < 200 ms (seek)
Full Stroke CD < 200 ms (seek)

Maximum Data Transfer

Rates

CD ROM Read CD-ROM, CD-R Up to 24X

CD-RW Up to 24X

DVD ROM Read DVD+RW Up to 8X

DVD-RW Up to 8X DVD+R DL Up to 8X DVD-R DL Up to 8X

Technical Specifications - Optical and Removable Storage

DVD-ROM Up to 8X DVD-ROM DL Up to 8X DVD+R Up to 8X DVD-R Up to 8X

Power Source SATA DC power receptacle

> **DC Power Requirements** 5 VDC ± 5%-100 mV ripple p-p

DC Current 5 VDC -< 800 mA typical, <1600 mA maximum

10% to 80%

Operating Environmental Temperature 41° to 122° F (5° to 50° C)

(all conditions non-

condensing)

Relative Humidity

Maximum Wet Bulb 84° F (29° C)

Temperature

Operating Systems Supported

Windows 11, Windows 10, Windows 7 Professional 64-bit.

Windows Vista Business 64*. Windows 2000.

Red Hat® Enterprise Linux® (RHEL) 8, 9 Desktop/Workstation

SUSE Linux® Enterprise Desktop 15

Ubuntu 20.04, 22.04 LTS

* No driver is required for this device. Native support is provided by the

operating system

Kit Contents HP SATA DVD Writer drive, installation guide.

NOTE: Actual speeds may vary. No support for DVD-RAM (DVD Writer). Does not permit copying of commercially available DVD movies or other copyright protected materials. Intended for creation and storage of your original material and other lawful uses. Double Laver discs can store more data than single layer discs. However, double-layer discs burned with this drive may not be compatible with many existing single-layer DVD drives and players.



Technical Specifications - Optical and Removable Storage

HP 9.5mm Slim DVD-ROM Description 9.5mm height, tray-load

Mounting Orientation Either horizontal or vertical

Interface Type SATA/ATAPI

Dimensions (WxHxD) 128 x 9.5 x 127mm

Disc Capacity DVD-ROM Single layer: Up to 4.7 GB

Double laver: Up to 8.5 GB

Access Times DVD-ROM Single Layer < 110 ms (typical)

> **CD-ROM Mode 1** < 110 ms (typical) **Full Stroke DVD** < 230 ms (typical) **Full Stroke CD** < 220 ms (typical)

Power SATA DC power receptacle Source

> **DC Power Requirements** 5 VDC ± 5%-100 mV ripple p-p

DC Current 5 VDC -< 800 mA typical, <1600 mA maximum

Operating Environmental Temperature 41° to 122° F (5° to 50° C)

(all conditions non-

Relative Humidity 10% to 80% condensing) **Maximum Wet Bulb** 84° F (29° C)

Temperature

Operating Systems

Windows 11, Windows 10, Windows 8.1, Windows 7 Professional 64-bit Supported

Red Hat® Enterprise Linux® (RHEL) 8, 9 Desktop/Workstation

SUSE Linux® Enterprise Desktop 15

Ubuntu 20.04, 22.04 LTS

No driver is required for this device. Native support is provided by the

operating system.

Kit Contents 9.5mm Slim DVD-ROM Drive, 5.25"" ODD Bay adapter/carrier, slim SATA

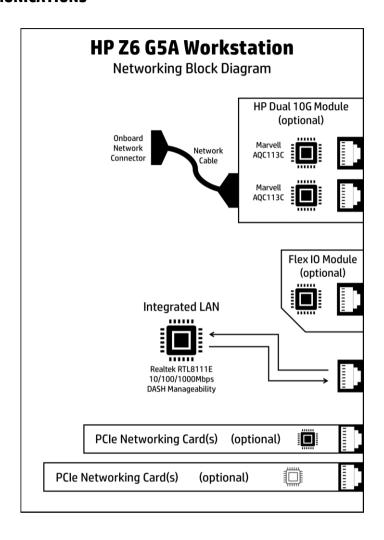
data/power cable, installation quide

NOTE: Actual speeds may vary. No support for DVD-RAM (DVD Writer). Does not permit copying of commercially available DVD movies or other copyright protected materials. Intended for creation and storage of your original material and other lawful uses. Double Layer discs can store more data than single layer discs. However, double-layer discs burned with this drive may not be compatible with many existing single-layer DVD drives and players.



Technical Specifications - Networking and Communications

NETWORKING AND COMMUNICATIONS



Realtek RTL 8111EPP (Integrated)

Connector RJ-45 (Single Port)

Cabling Twisted Pair Cabling, up to 100 meter, 1GbE on CAT 5 UTP and up, 10Mbps

on CAT 3 UTP

Controller Realtek RTL8111-EPP 1GbE platform LAN networking controller

Memory 128 bit Tx Buffer, 512 bit Rx buffer

Data Rates Supported 10/100/1000 Mbps

Compliance IEEE 802.3, 802.3u, 802.3ab, 802.1Q, 802.3az-2010 (EEE), 802.3x, 802.1P

NDIS5, NDIS6 (IPv4, IPv6, TCP, UDP), Checksum and Segmentation Task-offload, EMAC-393 ProxZzzy ECMA proxy for sleeping host standard, PCIe

3.0 LTR

Bus Architecture PCI Express, USB Redirection, and SMBus

Data Transfer Mode PCIe-based interface for active state operation (SO state) and SMBus for

host and management traffic (Sx and low power states)

Power Requirement 3.3V supplied by platform

Boot ROM Support Yes

Network Transfer Mode Full Duplex



Technical Specifications - Networking and Communications

Network Transfer Rate 1000BASE-T Full-Duplex

100BASE-TX Full-Duplex 100BASE-TX Half-Duplex 10BASE-T Full-Duplex 10BASE-T Half-Duplex

Management Capabilities WOL, PXE, UEFI, ASF 2.0, DASH,

Crossover Detection and Auto-correction, polarity correction, adaptive equalization, cross-talk and echo cancellation, timing recovery, error

correction

ACPI and OSPM, APM, Microsoft Wake Packet Detection, VLAN, RSS, OBFF,

Speed Auto-Negotiation, Jumbo frames up to 9kB, software KVM,

NVIDIA® Mellanox® ConnectX-6 DX Dual Port 10/25GbE SFP28 NIC

Connector 2 x SFP28 Transceiver Cage (Dual Port)*

Cabling Depends on transceiver pairing. Typically OM4 or higher MMF LC fiber optic

cabling with LC SFP28 Transceivers.

Controller ConnectX6-DX

Memory 256Mbit SPI Quad Flash Device

Data Rates Supported 1/10/25GbE *

IEEE 802.3by, 802.3ae, 802.3ap, 802.3ad, 802.1AX, 802.1Q, 802.1P, 802.1Qau (QCN), 802.1Qaz (ETS), 802.1Qbb (PFC), 802.1Qbg, 1588v2

Jumbo frame support (9.6KB) CB/cTUVus/CE Compliant CE/FCC/VCCI/RCM Compliant

RoHS/KCC/CAN ICES-3 (B)/NM EN 55035/55032 (Morocco)/UKCA Compliant

Bus Architecture PCle Gen 4 x8

Data Transfer Mode PCI Express - stores and accesses Ethernet fabric connection information

and packet data

Power Requirements 11.5 Watts (typical)
Network Transfer Rate 15.5 Watts (typical)
16.5 Watts (typical)

NOTE: Network Transfer Rate depends on transceiver model.*

Kit Contents NVIDIA® Mellanox® ConnectX-6 DX Dual Port 10/25GbE SFP28 NIC

* You must have a transceiver installed in order to connect this card to a network.

HP 25GbE SFP28 LC Fiber Connector
Optic Transceiver Cabling

Connector LC Fiber Optic Connector

Cabling Typically OM4 or higher MMF LC fiber optic cabling, up to 100m on OM4, up

to 70m on 0M3

Data Rates Supported 25Gbps

Compliance SFF-8472 and 8431, Hot pluggable SFP+ footprint

Compatibility Intended for use with NVIDIA Mellanox ConnectX-6 DX Dual Port 10/25GbE NIC

Wavelength 850nm

Kit Contents 25GbE SFP28 Transceiver



Technical Specifications - Networking and Communications

HP 10GbE SFP+ SR/SW LC Connector Fiber Optic Transceiver Cabling

Connector LC Fiber Optic Connector

Cabling Typically OM4 or higher MMF LC fiber optic cabling, up to 300m on MMF

Data Rates Supported 10Gbps

Compliance SFF-8472 and 8431, Hot pluggable SFP+ footprint

Compatibility Intended for use with NVIDIA Mellanox ConnectX-6 DX Dual Port 10/25GbE NIC

Wavelength 850nm

Kit Contents 10GbE SFP+ Transceiver

HP Dual Port 10GBase-T NIC Module G2 **Networking Interface** 2 x RJ-45 (Dual Port)

System Interface Cabled from Dedicated Rear I/O Slot

Controller Marvell AQC113C

Memory 128KB Tx Buffer, 192KB Rx Buffer on-chip

Networking Speeds

Supported

10Gbps, 5Gbps, 2.5Gbps, 1Gbps, 100Mbps, 10Mbps

Compliance IEEE 802.3 - 2018, IEEE 802.1AS-2011

Cabling (up to 100m) Cat5e (or higher) for 1Gbps

Cat6a (or higher) for 10Gbps

Power Consumption (active-typical)

Physical Dimensions

Connect Speed LED Indicators

5.5W at 1Gbps 11.2W at 10Gbps

0.875 in x 3 in x 2.75 in

Link/Activity LEDOff = No link

• Blinking = Activity

Speed LED

Amber = 1Gbps

• Green = 10Gbps

Operating Temperature 0 °C to 55 °C

0 °C to 55 °C (32 °F to 131 °F)

Intel® X550 10GBASE-T Dual Port NIC **Connector** 2 x RJ-45 (Dual Port)

Cabling Cat5 (or higher) for 100Mbps

Cat5e (or higher) for 1Gbps, 2.5Gbps, or 5Gbps Cat6 (or higher) for 10Gbps up to 55m Cat6a (or higher) for 10Gbps up to 100m

Controller Intel® X550-AT2

Memory Jumbo Frames up to 15.5KB, 64 Tx and 64 Rx Queues per port, 160KB/port

of programmable memory transmit buffers

Data Rates Supported

100Mbps (BASE-TX), 1Gbps (BASE-T, 2.5Gbps, 5Gbps, 10Gbps

Compliance 802.1q (VLAN), 802.1Qbb, 802.1p, 802.1Qaz

Bus Architecture PCle 3x4

Data Transfer Mode PCle Gen 3 x4 based interface

Power Requirements 3.9W at 100Mbps

Technical Specifications - Networking and Communications

5.5W at 1Gbps 11.2W at 10Gbps

Boot ROM Support Yes

Network Transfer Mode Auto negotiation between 1GbE, 2.5GbE, 5GbE and 10GbE

Management Capabilities DMI 2.0 Support, Windows Management Instrumentation (WMI) and SNMP,

PXE 2.0 through boot ROM, Multi-mode I/O Virtualization, VxLAN, VMDq,

VLAN support with VLAN tag insertion

Kit Contents Intel® X550 10GBASE-T Dual Port NIC

HP 10GBase-T Flex Port Connector RJ45 (Single Port)

Cabling Twisted Pair Cabling, up to 100m

Cat5e (or higher) for 1Gbps Cat6a (or higher) for 10Gbps

Controller Marvell AQC113C

Memory 128KB Tx Buffer, 192KB Rx Buffer on-chip

Data Rates Supported 10/100/1000 Mbps and 2.5/5/10 Gbps

Compliance IEEE 802.3 - 2018, IEEE 802.1AS-2011

Bus Architecture PCI Express and SMBus

Data Transfer Mode PCle-based interface for active state operation (SO state) and SMBus for

host and management traffic

Power Consumption

(typical)

5.5W at 1Gbps 11.2W at 10Gbps

Network Transfer Mode Full-duplex, Half-duplex

Network Transfer Rate 10GBASE-T

5GBASE-T 2.5GBASE-T 1000BASE-T 100BASE-TX 10BASE-Te

Management Capabilities WOL, PXE, UEFI,

Kit Contents HP 10GBase-T Flex Port NIC Module

Intel® I226-T1 1 port 2.5GbE NIC **Connector** 1xRJ-45

Cabling Cat5e (or higher) for 2.5Gbps up to 100m

Controller Intel® I226

Memory Jumbo Frames up to 9.5KB, 4 Tx and Rx Queues

Data Rates Supported 10Mbps, 100Mbps, 1Gbps, 2.5Gbps

Compliance IEEE 802.3 auto negotiation, 802.3, 802.3u, 802.3ab, 802.3x, 802.3z,

IEEE1588 protocol and 802.1AS implementation, 802.3az EEE

Bus Architecture PCI Express 2.1 x4

Data Transfer Mode PCIe-based interface for active state operation

Power Requirements 1.4W typical at 2.5Gbps

Technical Specifications - Networking and Communications

Network Transfer Mode Multi-speed, full, and half-duplex
Network Transfer Rate 10BASE-T 100BASE-Tx 1000BASE-T

Management Capabilities WOL, PXE 2.1, UEFI, Power Management Protocol Offload (proxying), MAC

Power Management, Active State Power Management, ACPI

Kit Contents Intel® I226-T1® Adapter

HP 2.5GbE LAN Flex Port Connector RJ45 (Single Port)

Cabling Copper twisted pair, Cat5e up to 100 meters

Controller Intel® I225-V

Memory 4 Tx and 4 Rx Queues, Jumbo Frames up to 9KB and without TSN

Data Rates Supported 10/100/1000Mbps and 2.5Gbps BASE-T

Compliance IEEE 802.3, 802.3u (auto-negotiation), 802.3ab, 1588, 802.1AS-Rev,

802.1Qav, 802.1Qbu, 802.1Qbv, 802.3br, 802.3az

Bus Architecture PCIe G2x1

Data Transfer Mode PCIe-based interface for active state operation (SO state) and SMBus for

host and management traffic (Sx low power state)

Power Requirements 2.2 Watts

Network Transfer Mode Automatic link configuration for speed duplex and flow control

Network Transfer Rate 2500BASE-T

1000BASE-T

100BASE-TX (Half-duplex supported) 10BASE-Te (Half-duplex supported)

Management Capabilities WOL, PXE, UEFI, Error Correcting Memory in packet buffers, UDP/TCP/IP

Checksum Offload, SCTP receive and transmit integrity offload

Kit Contents HP 2.5GbE LAN Flex Port Networking Interface Card

HP 1GbE Fiber LC Single Flex Port

Connector LC (Little Connector) Fiber (Single Port)

Controller AT-29M2

Data Rates Supported 1GBASE-SX

Bus Architecture USB 3.1G1

Power Requirements Up to 3.3 Watts

Network Transfer Mode 1GBASE-SX Network Transfer Rate 1GBASE-SX

Management CapabilitiesWake on LAN, Digital Diagnostic MonitoringKit ContentsHP 1GbE Fiber LC Single Flex Port NIC

HP Flex 1GbE Single Port Connector NIC Cabling

Connector RJ45 (Single Port)

Cabling 1GbE over Category 5e (or better) up to 100m

Controller Realtek RTL8153

Data Rates Supported 10/100/1000 Mbps

Bus Architecture USB3.1G1, USB2

Power Requirements Requires 3.3V (integrated regulators for core Vdc)

Network Transfer Mode Full-duplex; Half-duplex



Technical Specifications - Networking and Communications

Network Transfer Rate 10BASE-T (half-duplex) 10 Mbps

> 10BASE-T (full-duplex) 20 Mbps 100BASE-TX (half-duplex) 100 Mbps 100BASE-TX (full-duplex) 200 Mbps 1000BASE-T (full-duplex) 2000 Mbps

Management Capabilities Wake on LAN, PXE, UEFI **HP 1GbE Single Flex Port Kit Contents**

Intel® Ethernet 1350-T4V2 4-Port 1Gb NIC (After Market Option Only)

4x RJ-45 (Quad Port) Connector

Cat3 (or higher) for 10Mbps Cat5 (or higher) for 100Mbps Cat5e (or higher) Cabling

for 1Gbps up to 100m

Controller Intel® 1350

Memory Jumbo Frames up to 9.5KB, 8 Tx/Rx Queue pairs per port, Main Internal

memory is Error Code Correcting

Data Rates Supported

10Mbps, 100Mbps, 1Gbps

Compliance IEEE 802.3 auto negotiation, 802.3, 802.3u, 802.3ab, 802.3x, 802.3z,

IEEE1588 protocol and 802.1AS implementation, 802.3az EEE

Bus Architecture PCI Express 2.1 x4

Data Transfer Mode PCIe-based interface for active state operation

Power Requirements

Network Transfer Mode Multi-speed, full, and half-duplex 10BASE-T 100BASE-Tx 1000BASE-T **Network Transfer Rate**

Management Capabilities WOL, PXE 2.1, UEFI, Power Management Protocol Offload (proxying), MAC

Power Management, Active State Power Management, VLAN, ACPI

Kit Contents

Intel® Ethernet I350- T4V2 4-Port 1Gb NIC, installation instructions

Allies Telesis AT-2914SX/LC 1GB LC Fiber NIC

Connector LC Fiber (Single Port)

Cabling 50/125 µm (core/cladding) multimode fiber optic cable up to 500m

62.5/125 µm (core/cladding) multimode fiber optic cable up to 220m

Memory Jumbo Frames up to 9.6KB

Data Rates Supported 1000SX (1GbE Fiber at 850nm Wavelength)

Compliance IEEE 802.1p (Quality of Service), IEEE 802.1Q (VLANs), IEEE 802.2 (LLC),

IEEE 802.3ac (MAC), IEEE 802.3x (Flow control auto-negotiation), IEEE

802.3z (1000 Base-X), IEEE 802.3ad (Link aggregation)

RoHS, UL, FCC/EN55022 Class A, TUV, EN55024, CE, C-TICK, VCCI

Bus Architecture PCle x1

Data Transfer Mode PCIe-based interface **Power Requirements** 1.5 Watts (typical)

1000SX only (1GbE Fiber at 850nm Wavelength) **Network Transfer Rate**

Management Capabilities UEFI. Smart Load Balancing and failover. Link aggregation (IEEE802.3ad).

Generic trunking (FEC/GEC) / IEEE 802.3ad-draft static, VLAN Support

Kit Contents Allied Telesis AT-2914SX/LC 1GB LC Fiber NIC with low-profile bracket

attached and standard height bracket included

Technical Specifications - Networking and Communications

Allied Telesis AT-2911T/2-901 Dual Port 1GbE NIC Connector 2 x RJ-45 (Dual Port)

Cabling Cat3 (or higher) for 10Mbps
Cat5 (or higher) for 100Mbps

Cat5e (or higher) for 1Gbps up to 100m

Memory 17 Rx and 16 Tx queues

Data Rates Supported 10/100/1000 Mbps

Compliance IEEE 802.1p (Quality of Service), IEEE 802.1Q (VLANs), IEEE 802.2 (LLC),

IEEE 802.3ac (MAC), IEEE 802.3x (Flow control auto-negotiation), IEEE 802.3z (1000 Base-X), IEEE 802.3ad (Link aggregation), IEEE 802.3ab

(10/100/1000T)

RoHS, UL, FCC/EN55022 Class A, TUV, EN55024, CE, C-TICK, VCCI

Bus Architecture PCle 2x1

Data Transfer ModePCIe-based interfacePower Requirements2.4 Watts (typical)

Management Capabilities VLAN support, Link aggregation LACP, Link aggregation smart switch,

Failover, Smart Load Balancing (SLB), iSCSI boot support, Windows

Management Instrumentation (WMI), PXE 2.1, SNMP

Kit Contents Allied Telesis AT-2911T/2-901 Dual Port 1GbE NIC with low-profile bracket

attached and standard bracket included

MediaTek RZ616 Wi-Fi 6 + Connector Bluetooth® 5.3 wireless card Flex Port NIC with Internal Antenna

Controller

Connector Wireless Cabling N/A

Controller MediaTek RZ616

Data Rates Supported Wi-Fi 6 (2.4GHz/5GHz)

(20MHz, 40MHz, 80MHz, 160MHz)

Compliance IEEE 802.11 a/b/g/n/ac/ax

IEEE 802.11 d/e/h/i/j/k/mc/r/v/w

Bus Architecture PCIe G2.1 for WLAN, USB2.0 for BT

Capabilities Wi-Fi:

MU-MIMO TX/RX, STBC, LDPC

Greenfield, mixed mode, legacy mode

Security support for WFA WPA/WPA2/WPA3 personal, WPS2.0

QoS support of WFA WMM, WMM PS

BT:

BT 2.1, 3.0, 5.3

Up to 7 BT links and 16BLE links SCO and eSCO link with retransmission

Packet Loss Concealment (PLC) for voice quality

AES128 and ECC256

Kit Contents MediaTek RZ616 Wi-Fi 6 + Bluetooth® 5.3 Flex Port NIC

Installation Instructions

* Wireless access point and Internet service required and sold separately. Availability of public wireless access points limited. Wi-Fi 6 (802.11ax) is backwards compatible with prior 802.11 specs.

Intel® AX210 Wi-Fi 6E non-vPro + Bluetooth® 5.2 wireless card with External Antenna WLAN Connector Wireless Cabling N/A

Controller Intel® AX210

Data Rates Supported Wi-Fi 6E (2.4GHz/5GHz/6GHz)

Technical Specifications - Networking and Communications

Compliance Wi-Fi Alliance CERTIFIED 6, WiFi CERTIFIED a/b/g/n/ac,

WMM, WMM-Power Save, WPA2, WPA3, Wi-Fi Direct, and Wi-Fi Agile

Multiband

IEEE WLAN Standard 802.11-2016, 802.11a, b, d, e, g, h, I, k, n, r, u, v, w, ac,

and ax. Bluetooth® 5.2

Bus Architecture PCIe G3x1 for WLAN, USB3.1G1 for BT

Management Capabilities Authentication Protocols: 802.1X EAP-TLS, EAP-TTLS/MSCHAPv2, PEAPv0 -

MSCHAPv2 (EAP-SIM, EAP-AKA, EAP-AKA')

Encryption: 128-bit AES-CCMP, 256-bit AES-GCMP

UEFI

Kit Contents Intel® AX210 Wi-Fi 6 + Bluetooth® 5.2 PCIe NIC

External Dipole Antenna Installation Instructions

*Wi-Fi 6E requires a Wi-Fi 6E router, sold separately to function in the 6GHz band. Availability of public wireless access points limited. Wi-Fi 6E is backwards compatible with prior 802.11 specs. And available in countries where Wi-Fi 6E is supported.

Date of change:	Version History:		Description of change:
December 1, 2023	From v1 to v2	Changed	Other Hardware section
January 17, 2024	From v2 to v3	Changed	Operating Systems section
January 24, 2024	From v3 to v4	Changed	Format
February 1, 2024	From v4 to v5	Changed	STORAGE/HARD DRIVES, Graphics, Social and Environmental Responsibility sections
March 1, 2024	From v5 to v6	Changed	Operating Systems, Graphics sections
April 1, 2024	From v6 to v7	Changed	Graphics, HP Remote System Controller, Certification and
			Compliance sections
May 1, 2024	From v7 to v8	Changed	Graphics, Social and Environmental Responsibility sections
June 1, 2024	From v8 to v9	Changed	Storage section
July 1, 2024	From v9 to v10	Changed	Graphics section
July 18, 2024	From v10 to v11	Changed	Software section
August 1, 2024	From v11 to v12	Changed	Memory section
August 23, 2024	From v12 to v13	Changed	NETWORKING AND COMMUNICATIONS section
September 2, 2024	From v13 to v14	Changed	NETWORKING AND COMMUNICATIONS section
November 1, 2024	From v14 to v15	Changed	On-Board RAID Support section
November 13, 2024	From v15 to v16	Changed	Page 24
January 8, 2025	From v16 to v17	Changed	Graphics section



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